

# **DSP56009EVM**

## **User's Manual Revision 1**


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## Introduction

This document supports the DSP56009 Evaluation Module (DSP56009EVM) including a description of its basic structure and operation, the equipment required to use it, the specifications of the key components, the provided software (such as the demonstration code and the software required to develop and debug sophisticated applications), schematic diagrams, and a parts list. Section 1 is a Quick Start Guide. Section 2 provides evaluation module specifications. Section 3 provides peripheral specifications. Section 4 provides schematics for the DSP56009EVM. Section 5 provides PLD equations and schematics and the parts list. Section 6 provides an example program and information on the debugger. Appendix A documents the audio pass-through demonstration program provided with the EVM. Appendix B describes the sound field processing demonstration. Appendix C includes additional notes for using the Assembler. This document has been designed for users experienced with DSP development tools. For users with little or no DSP experience, detailed information is provided in the additional documents supplied with this kit.

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# **SECTION 1**

## **QUICK START GUIDE**

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## 1.1 OVERVIEW

This document describes the basic structure, theory, and operation of the DSP56009EVM (Evaluation Module), the equipment required to use the Evaluation Module, and the specifications of the key components on the Evaluation Module. Code samples and self-test code are provided on the accompanying software diskette. Evaluation Module schematic diagrams and a parts list are included as well.

## 1.2 EVALUATION MODULE DESCRIPTION AND FEATURES

The DSP56009EVM is a low-cost platform for multichannel digital audio applications design, prototyping, and development. The fully assembled and tested circuit board contains:

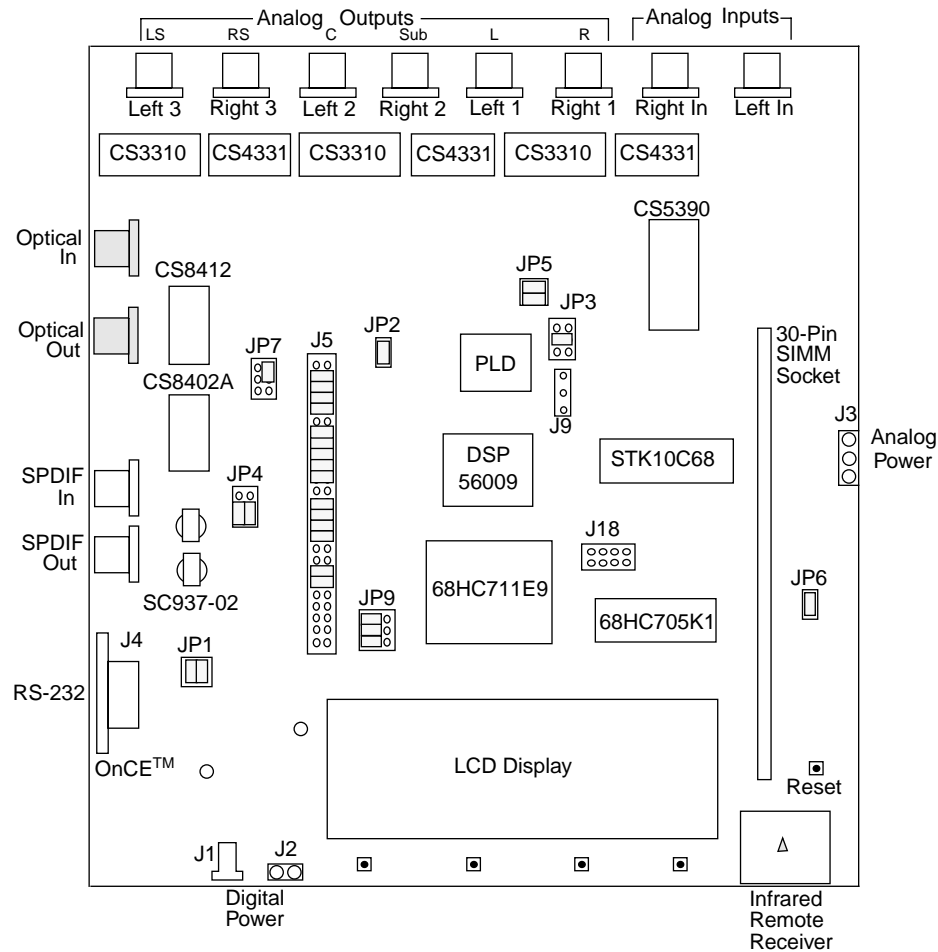
- 24-bit DSP56009 Digital Signal Processor operating at 81 MHz for Dolby AC-3 and Dolby ProLogic
- 8192 bytes of off-chip SRAM and 8192 bytes of nonvolatile RAM
- Standard 30-pin SIMM slot for easy, inexpensive DRAM expansion
- One 20-bit stereo Analog-to-Digital converter (ADC), three 18-bit stereo Digital-to-Analog converters (DACs)
- Programmable analog-domain attenuators on the Digital-to-Analog outputs
- RCA jacks for all analog audio Input/Output
- Optical and transformer-isolated electrical SPDIF/CP340 stereo digital audio inputs and outputs
- 50-pin expansion connector to provide the capability for expansion and/or substitution of other input/output peripherals, as well as easy interprocessor communication between Motorola Evaluation Modules
- Socketed MC68HC711E9 (52-pin CLCC microcontroller) to allow the user to substitute user-programmed microprocessor and prototype custom 68HC711 code (allows connection to MC68HC711 emulation systems)
- $2 \times 16$  character Liquid Crystal Display (LCD) and four softswitches for user interface
- Connector provides capability to use optional standard  $4 \times 4$  keypad matrix
- MC68705K1 microcontroller performing RS-232-to-OnCE™ port command conversions

## 1.3 EQUIPMENT

The following section gives a brief summary of the equipment required to use the Evaluation Module, some of which is supplied with the Evaluation Module, and some of which will have to be supplied by the user.

### 1.3.1 What you get with the Evaluation Module

- Evaluation Module board (See **Figure 1-1**)
- 3.5" disk titled 'Debug - Evaluation Module'
- 3.5" disk titled 'DSP56009EVM Demos'
  - PCM Passthrough Files
  - Soundfield Processor Files
  - Example Assembly Language Files (example.asm)
- Debug - Evaluation Module manual
- DSP56000 Family Manual
- DSP56009 User's Manual
- DSP56009 Technical Data sheet
- DSP56009 Product Brief
- DSP56009 EVM User's Manual (this document), including Evaluation Module Schematics and Demonstration software documentation
- Additional relevant documentation may be included in the form of a READ.ME file on the Evaluation Module Software disk.



**Figure 1-1** Evaluation Module Component Layout

### 1.3.2 What you need for AC-3/ProLogic Demonstration

- An AC-3 or PCM bitstream source (i.e. Laserdisc, DAT, CD source, VHS, etc...)
- An audio amplifier driving headphones or speakers as shown on the following page in **Figure 1-2**.
- Power supplies: dual 8-12V DC (for analog circuits), 8-15V AC or DC (for digital circuits)

### 1.3.3 What you need to supply for software development

- A PC (-386 or higher) with minimum 2 Mbytes of memory, a 3.5" floppy disk drive, and a serial port capable of at least 19,200 bits-per-second data transfer rate.
- An RS-232 cable (DB9 male to DB9 female)

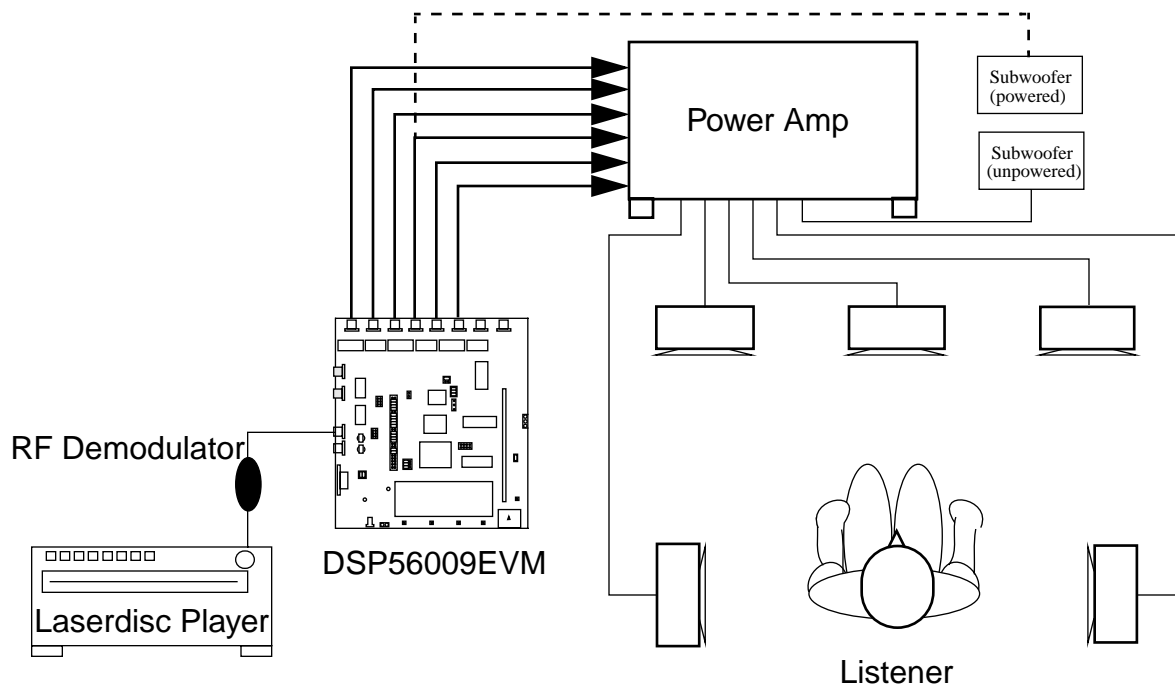


Figure 1-2 AC-3 Home Theater Demonstration

## 1.4 INSTALLATION PROCEDURE

Installation requires four basic steps:

1. Preparing the DSP56009EVM board
2. Connecting the board to the PC and power
3. Installing the software



#### 4. Testing the installation

##### 1.4.1 Preparing the DSP56009EVM

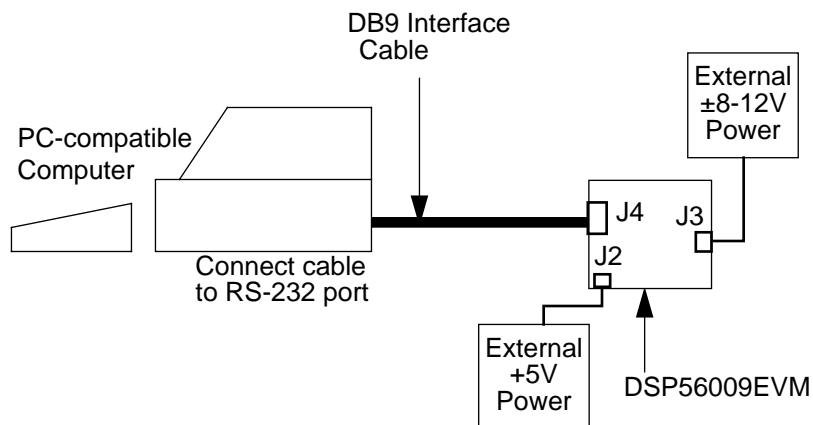
### **CAUTION**

Because all electronic components are sensitive to the effects of electrostatic discharge (ESD) damage, correct procedures should be used when handling all components in this kit and inside the supporting personal computer. Use the following procedures to minimize the likelihood of damage due to ESD:

- Always handle all static-sensitive components only in a protected area, preferably a lab with conductive (anti-static) flooring and bench surfaces.
- Always use grounded wrist straps when handling sensitive components.
- Never remove components from anti-static packaging until required for installation.
- Always transport sensitive components in anti-static packaging.

### 1.4.2 Connecting the DSP56009EVM to the PC and Power

**Figure 1-3** shows the interconnection diagram for connecting the PC and the external power supply to the DSP56009EVM board. Use the following steps to complete cable connections:



**Figure 1-3** Connecting the DSP56009EVM Cables

1. Connect the DB9P end of the RS-232 interface cable to the RS-232 port connection on the PC.
2. Connect the DB9S end of the cable to J4, shown in **Figure 1-1** on page 1-15, on the DSP56009EVM board. This provides the connection to allow the PC to control the board function.
3. Make sure that the external power supplies do not have power supplied to them.
4. Connect the output power connectors into J2 and J3, shown in **Figure 1-1** on page 1-15, on the DSP56009EVM board.
5. Apply power to the power supply. The green Power LED will light when power is correctly applied.

### 1.4.3 Installing the Software

The DSP56009EVM demo software includes the following:

- Motorola diskette containing:
  - Demonstration code (passthru, sfpevm09, example)
- Domain Technologies diskette containing the windowed user interface debug software

Use the following steps to install the software:

1. Insert the Motorola software diskette into the PC diskette drive.
2. If the system is not already running in Windows, start Windows.
3. From Windows, select a DOS window and run the install program. The general format for the command line of the install program is ***install <source>***. For example, if your diskette drive is the a: drive, type in ***a:install a:***. The program installs the software in the default destination c:\evm56007.
4. Close the DOS window and remove the Motorola software diskette from the diskette drive. Insert the Domain Technologies diskette labeled Debug-56K into the drive.
5. From Windows, run the Debugger installation program install.exe on the diskette. This can be done from the Microsoft Windows Program Manager by pulling down the File menu, choosing Run, entering ***a:install*** on the command line, and clicking OK.
6. Read the README.TXT if you are installing the Debugger program for the first time. This provides information in addition to that provided by the Domain Technologies manual included with this kit.
7. The install program creates a program group called EVM56007 and a program icon called EVM56007 within Windows. This step completes the software installation.





# **SECTION 2**

## **EVM THEORY OF OPERATION**

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Refer to **Section 4, DSP56009 Schematics** for reference to pinouts and jumper configurations.

## 2.1 INPUTS AND OUTPUTS

Analog signals connected to the Evaluation Module inputs are converted to 20 bit data at the ADC. U19 and U20 attenuate the signal and convert it to Balanced mode.

The ADC has the Select Serial I/O Mode (SMODE) pin pulled high to make the ADC the SAI receive clock master. When the ADC is in Master mode, the ADC's Serial Data Clock (SCLK) and Left/Right Select (L/R) word clock pins are outputs. The L/R word clock output is the opposite polarity of I<sup>2</sup>S. It is inverted in the Programmable Logic Device (PLD) to create true I<sup>2</sup>S. The ADC receives its oversampling clock on the Digital Section Clock Input (ICLKD), which is then internally divided by two, and this signal is provided to the Analog Section Clock Input (ICLKA). ICLKD can be driven from the 11.2896 MHz clock, the 12.288 MHz clock, or the  $256 \times F_s$  clock produced by the CS8412 AES/EBU Receiver. The Audio Power Down input (APD) and Digital Power Down input (DPD) pins are wired to the Cntl\_Mute signal of the PLD. When pulled high, the ADC will be muted. When first pulled low, the ADC will be reset, then it will be enabled.

The other possible input source comes from the SPDIF inputs (J14 for electrical input and J17 for optical input). Jumper JP4 selects the source (see **Table 2-1** below). When receiving valid SPDIF input, the SPDIF Receiver drives the Master Clock (MCK) output that is 256 times the Frame Sync frequency of the received data. The CS8412 operates in Mode 3, the I<sup>2</sup>S Slave mode.

**Table 2-1 JP4 Jumpers**

Selection	Jumper Settings
Electric SPDIF	JP4.1 to JP4.3 JP4.2 to JP4.4

**Table 2-1 JP4 Jumpers**

Selection	Jumper Settings
Optical SPDIF	JP4.3 to JP4.5 JP4.4 to JP4.6

### 2.1.1 Clock Select

The Evaluation Module provides a means for the user to select which clock controls the reception and transmission of digital audio (see **Table 2-2** below). JP2 selects the ADC and DAC clocks which, when jumpered, are set at 44.1 KHz and, when not jumpered, at 48 KHz. The expansion connector, J5, can be used to directly access the DSP. The receive SAI bus may be clocked by the selection made at JP2 (44.1 KHz or 48 KHz) or be clocked by the received SPDIF signal. The transmit SAI bus may be clocked by either the clock selected at JP2 or by the received SPDIF signal. It is the user's responsibility to ensure that data is output at the desired rate. See **Table 2-2**, below.

**Table 2-2 JP5 Jumpers**

Receive /Transmit	Jumper JP5.1 to JP5.2	Jumper JP5.3 to JP5.4	No Jumper
Rx	Clocked by crystal	—	Clocked by received SPDIF
Tx	—	Clocked by crystal	Clocked by received SPDIF

### 2.1.2 Serial Audio Interface (SAI)

The DSP56009 SAI transmitter drives the six analog outputs and the SPDIF output. I<sup>2</sup>S is the Default mode for the DACs. The Master Clock (MCLK) rate for the DACs is  $256 \times F_s$ . The dual RC networks after the DACs serve as AC couplers for audio data,



and as low-pass filters to convert the delta-sigma digital output pulses to analog waveforms.

The digitally controlled analog domain attenuators receive the audio data and attenuate or amplify the data as determined by the microcontroller. The attenuators receive the Serial Clock input (SCLK), Serial Data Input (SDATAI), and the Chip Select/latch (CS) from the microcontroller.

### **2.1.3 Sony-Philips digital interface format (SPDIF)**

The SPDIF transmitter receives data from the DSP through the Serial Data input (SDATA) using the Frame Sync (FSYNC) and the Serial Data Clock (SCK). The transmitter outputs SPDIF audio signals through J15 (electrical) and J16 (optical). Fs\_sens from the clock select appears at the expansion connector in order to read the sampling rate with the DSP's General Purpose I/O (GPIO1) at J5.41 and also at U21-2 to select the state of the 'sample-rate' bits transmitted within the channel status block. See the SPDIF specification for more information. The channel status bits and block sync signals (DRcv\_Blk, DTrn\_Blk, DRcv\_CS, and DTrn\_CS) are available at J5.43 to allow the DSP to read one of them, as well. Isolation transformers are used on both input and output, although they are not strictly required for SPDIF because this Evaluation Module is intended to be used as a development system.

### **2.1.4 Other inputs and Outputs**

The clock master is derived from one of two sources: the 11.2896 MHz clock or the 12.288 MHz clock. The microcontroller also receives commands from either the soft switches (S1, S2, S3, or S4) or from the Keypad Expansion Port, J18. The current user screen or the results of these commands are then displayed by a modular LCD panel with a  $2 \times 16$  character display. The microcontroller code is capable of driving larger LCD displays, but all user screens are designed for a  $2 \times 16$  character display.

The MC68HC711E9 communicates with the DSP via the Serial Host Interface (SHI) port in SPI mode. When SS is pulled low, the microcontroller can write to the DSP. The MOSI and MISO lines pass control data through the DSP SHI in 24-bit mode. SCK is the SPI Shift Clock from the DSP. Again, the expansion connector, J5, can be used to access or intercept host port communications.

The Control\_Data, Control\_Clock, and Control\_Latch lines from the microcontroller control the digitally controlled analog domain attenuators. The Control\_Mute line mutes the ADC and the DACs; low is muted, high is enabled.

### 2.1.5 Operating Mode Selection

DSP56009EVM modes can be selected at JP3, as shown in **Table 2-3**. Once the mode has been selected, the PLD can receive interrupts from the network attached to J19.

**Table 2-3 JP3 Jumpers**

Mode	JP3.5 to JP3.6	JP3.3 to JP3.4	JP3.1 to JP3.2
0	X	X	X
1	X	X	-
2	X	-	X
3	X	-	-
4	-	X	X
5	-	X	-
6	-	-	X
7	-	-	-

X = jumper installed; - = no jumper

### 2.1.6 OnCE™ Port

The OnCE™ port interface operates by receiving the serial data from the RS-232 Transceiver and executing commands sent by the host computer. These commands can reset the DSP, put the DSP in Debug mode, release the DSP from Debug mode, read and write to the OnCE™ port, and read and write to the DSP itself. The serial bit rate is 19,200 bits/second. The RS-232 serial communications are performed in software on the MC68705K1. Port A of the MC68705K1 communicates with the DSP, and Port B communicates with the host computer. The acknowledge signal from the OnCE™ port is a low-going pulse on DS0. Since the 68705K1 is too slow to reliably

catch this very narrow pulse, the pulse is latched in the PLD and the output of the latch appears on the ACK pin (PA2). When this occurs, the 68705K1 illuminates red LED D5 to indicate that the DSP is in the Debug mode. For more information on the OnCE port, see the DSP56000 Family Manual. The reset switch will reset the microcontroller, which will subsequently reset the DSP56009. The MC68705K1 source and object code are available from the Motorola DSP Division; contact your local Motorola FAE.

### **2.1.7 RS232 Connections and JP1**

RS-232 is an often-abused standard, and the direction of the signals present on pins 2 and 3 of the DB9 connector do not always conform to the standard. JP1 provides the user with the ability to reverse these two pin connections without resorting to NULL Modem adapters or rewiring cable connectors. As shipped, JP1.1 is connected via shorting jumpers to JP1.3 and JP1.2 is connected to JP1.4. This connects J4.2 to the OUTPUT of the Evaluation Module's RS-232 level converter (U4) and J4.3 to the INPUT of the board's RS-232 receiver. These directions can be reversed by reorienting the shorting jumpers and turning them 90 degrees (one-quarter turn), thereby connecting JP1.1 to JP1.2 and JP1.3 to JP1.4. The user should never need to rewire an RS-232 connector in order to establish Evaluation Module communications with a host computer.

### **2.1.8 Operating Modes and SRAM refresh in the 56009**

In Modes 0, 1, 2, and 3 the SRAM is refreshed from the nvRAM and the DSP can bootstrap from the SRAM via the EMI if a valid Bootstrap mode is used. When in Modes 4, 5, 6, and 7 the SRAM is not refreshed. Refreshes are not affected by jumpers on the expansion connector, J5. Jumpers J5.37 and J5.39 must be inserted to have full DSP control of the SRAM and nvRAM after bootstrap.

### **2.1.9 Evaluation Module Parts**

The parts list of the DSP56009EVM is shown in **Section 5**.

### **2.1.10 Power Supplies**

The Evaluation Module requires power sources, for both analog and digital circuits, in order to operate. Bipolar analog power (use a linear power supply for best results) is received through screw terminals at J3. Digital power is received through screw terminals at J2 or via a 2.1mm connector (J1). When the power is on, D6 (green LED) is illuminated. Analog power input may be 8 to 12 volts and digital power input may be 8 to 15 volts. While the voltage regulator can accommodate higher input voltage potentials, the added heat dissipation required at these input voltage levels will result in the regulator becoming dangerously warm, and it is not recommended that the user subject the board to power inputs in excess of the maximum levels listed.

**Note:** Always supply the Evaluation Module with analog power prior to or simultaneous with the application of digital power. If digital power is supplied before the analog power, the DACs may go into one of three possible error modes (no long-term damage to the device will occur), and will not function correctly. If analog power is supplied first, or if both analog power and digital power are applied simultaneously, these problems do not appear and the DACs are properly initialized.

### **2.1.11 Memory**

The Evaluation Module has 8192 bytes each of fast Static RAM (SRAM) and of nonvolatile RAM (nvRAM). The SRAM operates at zero wait states at a 40 MHz DSP clock speed, one wait state at 50, 66 MHz and two wait states at 81 MHz. The contents of the SRAM may be block-loaded into nvRAM and the contents of the nvRAM may be block-loaded into the SRAM. The lowest 3072 bytes of the nvRAM may also be used to store code to load into the DSP via EMI bootstrap.



# **SECTION 3**

## **PERIPHERAL SPECIFICATIONS**

3.1	CS5390 STEREO ADC . . . . .	3-31
3.2	CS4331 STEREO DAC . . . . .	3-32
3.3	CS3310 STEREO DIGITAL VOLUME CONTROL . . . . .	3-32
3.4	CS8412 DIGITAL AUDIO INTERFACE RECEIVER . . . . .	3-33
3.5	CS8402A DIGITAL AUDIO INTERFACE TRANSMITTER .	3-34
3.6	STK10C68 CMOS 2K X 8 NVSRAM . . . . .	3-35
3.7	SC937-02 AES/EBU TRANSFORMER . . . . .	3-35
3.8	LCD PANEL . . . . .	3-36
3.9	WIRING FOR KEYPAD . . . . .	3-39

The following section describes the various peripheral devices used on the DSP56009EVM and includes any necessary equations and information. Contact information for the manufacturers of significant peripheral devices is included along with the parts listing in **Section 5**.

### 3.1 CS5390 STEREO ADC

The CS5390 is a complete Analog-to-Digital Converter (ADC) for stereo digital audio systems. It performs sampling, analog-to-digital conversion and anti-alias filtering, generating 20-bit values for both left and right inputs in serial form. The output word rate can be up to 50 kHz per channel.

The CS5390 uses fifth-order, delta-sigma modulation with 64 times oversampling followed by digital filtering and decimation, which removes the need for an external anti-alias filter, beyond the simple balanced RC filter formed by R25, R26, and C8 (R31, R32, and C20 for the right channel).

The ADC uses a differential architecture that provides excellent noise rejection. The CS5390 has a filter passband of DC to 21.7 kHz. The filters are linear phase, have 0.005 dB passband ripple, and greater than 100 dB stopband rejection. The operating temperature range is 0° to 70°.

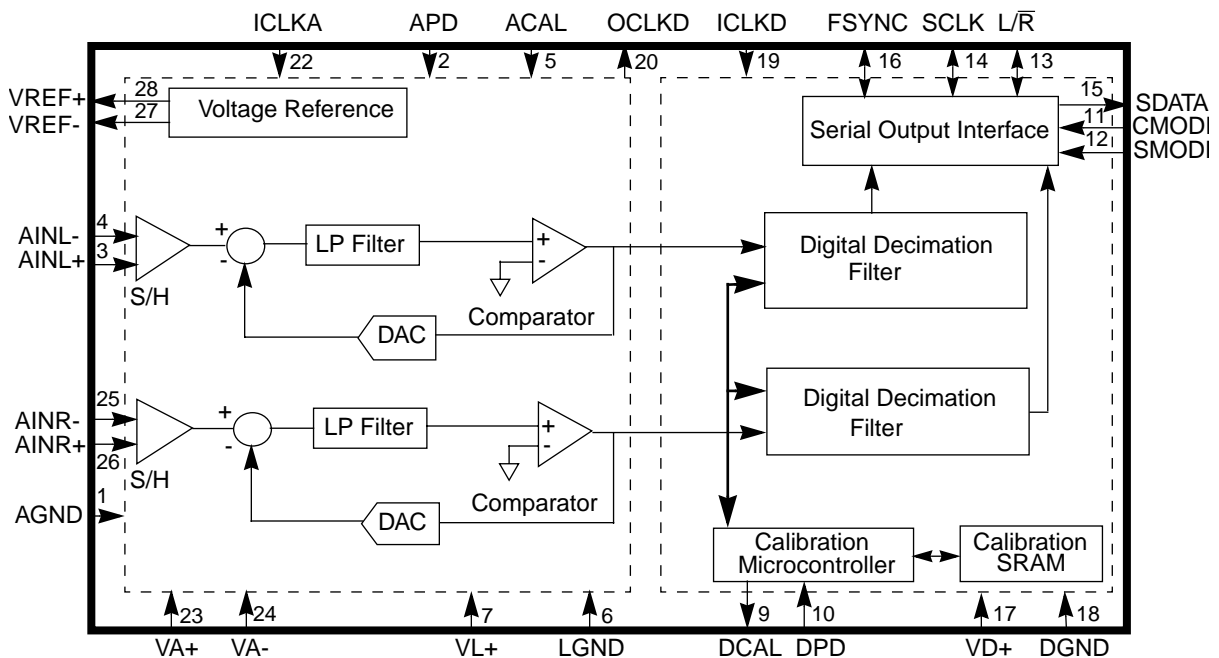


Figure 3-1 CS5390 ADC

### 3.2 CS4331 STEREO DAC

The CS4331 is a complete stereo Digital-to-Analog Converter (DAC) with 18-bit resolution, including interpolation, 1-bit digital-to-analog conversion, and output analog filtering in an 8-pin package. The CS4331 is based on delta-sigma modulation where the modulator output controls the reference voltage input to an ultra-linear analog low-pass filter. This architecture allows for infinite adjustment of sample rate between 1 kHz and 50 kHz while maintaining linear phase response, simply by changing the master clock frequency. The CS4331 contains optional on-chip de-emphasis and operates from a single +5 V power supply.

The CS4331 has a 96 dB dynamic range, less than 0.003% THD, low clock jitter sensitivity and completely filtered line level outputs that use linear-phase filtering.

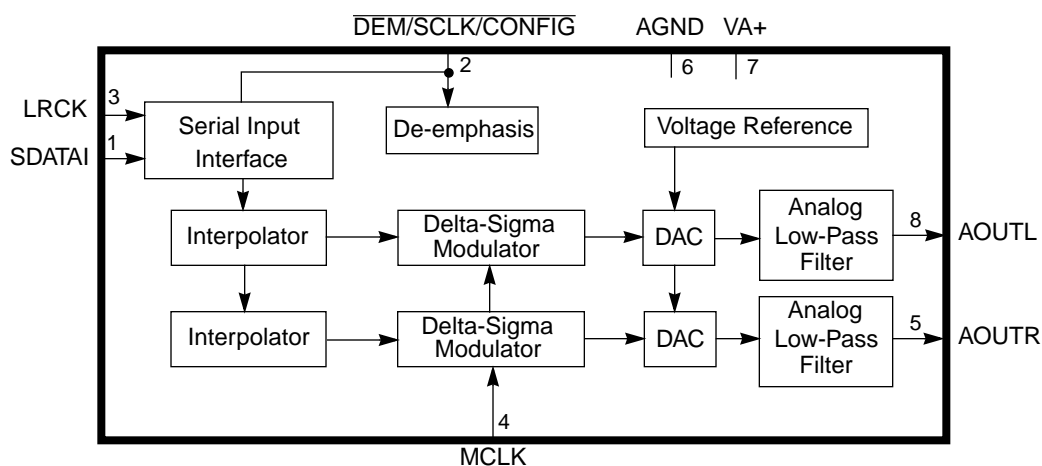


Figure 3-2 CS4331 DAC

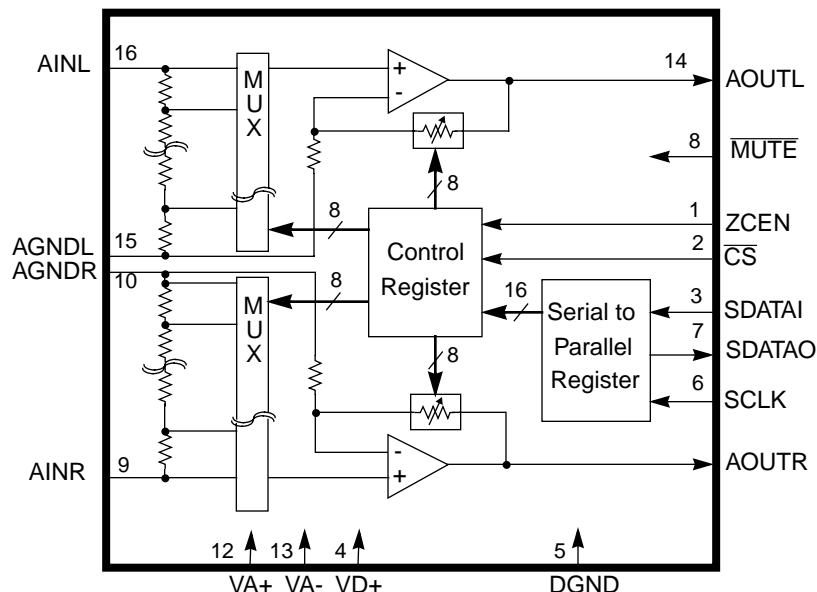
### 3.3 CS3310 STEREO DIGITAL VOLUME CONTROL

The CS3310 is a complete stereo digital volume control designed specifically for audio systems. It features a 16-bit serial interface that controls two independent, low distortion (0.001% THD + N) audio channels.

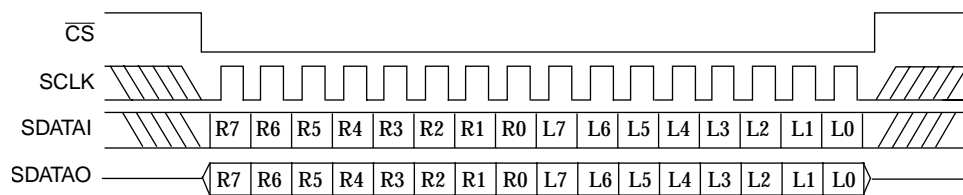
The CS3310 includes an array of well-matched resistors and a low-noise active output stage that is capable of driving a 600  $\Omega$  load. A total adjustable range of 127 dB, in 0.5 dB steps, is achieved through 95.5 dB of attenuation and 31.5 dB of gain.



The simple 3-wire interface provides daisy-chaining of multiple CS3310s for multi-channel audio systems. The device operates from  $\pm 5\text{V}$  supplies and has an input/output voltage range of  $\pm 3.75\text{ V}$ .



**Figure 3-3** CS3310 Stereo Digital Volume Control



L0 = Left Channel Least Significant Bit R0 = Right Channel Least Significant Bit  
L7 = Left Channel Most Significant Bit R7 = Right Channel Most Significant Bit

SDATA is latched internally on the rising edge of SCLK  
SDATAO transitions after the falling edge of SCLK  
SDATAO bits reflect the data previously loaded into the CS3310

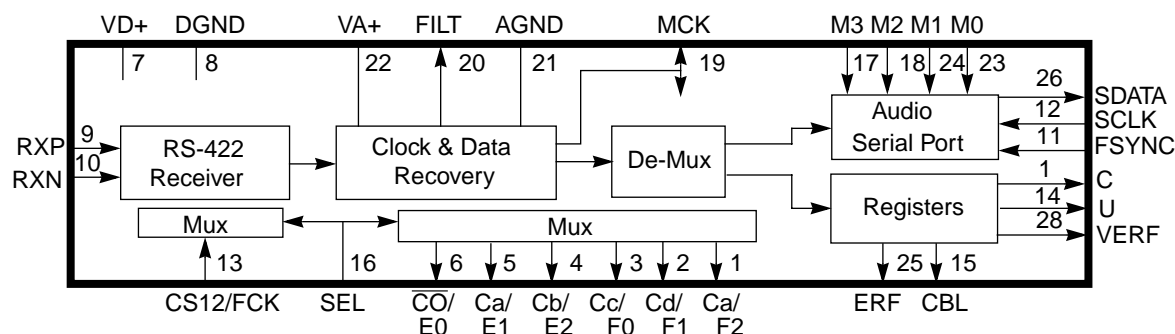
**Figure 3-4** Serial Port Timing for the CS3310

### 3.4 CS8412 DIGITAL AUDIO INTERFACE RECEIVER

The CS8412 is a monolithic CMOS device that receives and decodes audio data according to the AES 3 - 1992, EBU Tech. 3250-E, IEC 958, SPDIF, and EIAJ CP-340 interface standards. The CS8412 receives data from a transmission line, recovers the

**CS8402A Digital Audio Interface Transmitter**

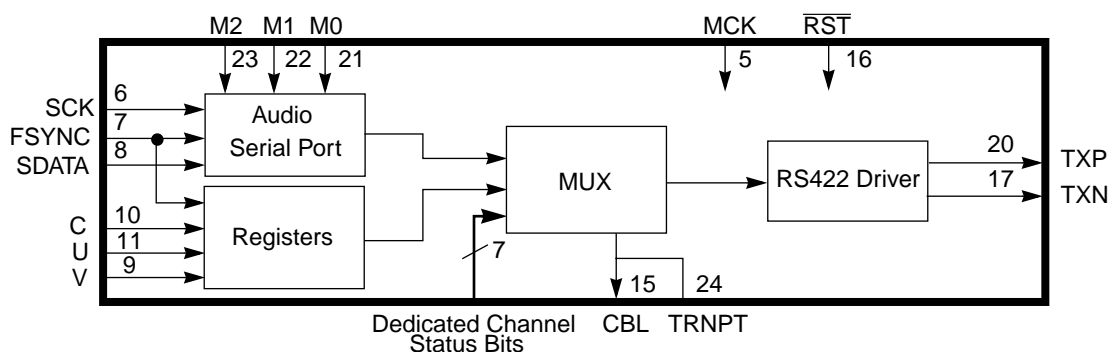
clock and synchronization signals, and de-multiplexes the audio and non-audio data. Either differential or single-ended inputs can be decoded. The CS8412 de-multiplexes the channel, user, and validity data directly to dedicated output pins for the most commonly needed channel status bits.



**Figure 3-5** CS8412 Digital Audio Interface Receiver

### 3.5 CS8402A DIGITAL AUDIO INTERFACE TRANSMITTER

The CS8402A is a monolithic CMOS device that encodes and transmits audio data according to the AES 3 - 1992, EBU Tech. 3250-E, IEC 958, SPDIF, and EIAJ CP-340 interface standards. The CS8402A accepts audio and non-audio data and multiplexes and encodes the data. The audio serial port is double-buffered and capable of supporting a wide variety of formats. The CS8402A multiplexes the channel, user, and validity data directly from dedicated input pins for the most commonly needed channel status bits.



**Figure 3-6** CS8402 Digital Audio Interface Transmitter

### 3.6 STK10C68 CMOS 2K X 8 NVSRAM

The Simtek STK10C68 is a Fast Static RAM (25, 30, 35, and 45ns), with a nonvolatile electrically-erasable PROM (EEPROM) element incorporated in each static memory cell. The SRAM can be read and written an unlimited number of times while independent, nonvolatile data resides in EEPROM. Data may easily be transferred from the SRAM to the EEPROM (STORE cycle), or from the EEPROM to the SRAM (RECALL cycle) using the NE pin (Nonvolatile Enable). It combines the high performance and ease of use of a fast SRAM with nonvolatile data integrity.

The STK10C68 features 12, 15, 20, and 25 ns output enable access times, hardware STORE and RECALL initiation, automatic STORE and RECALL timing,  $10^4$  or  $10^5$  STORE cycles to EEPROM, unlimited RECALL cycles from EEPROM, and 10-year data retention in EEPROM. The STK10C68 requires a single +5 V power supply.

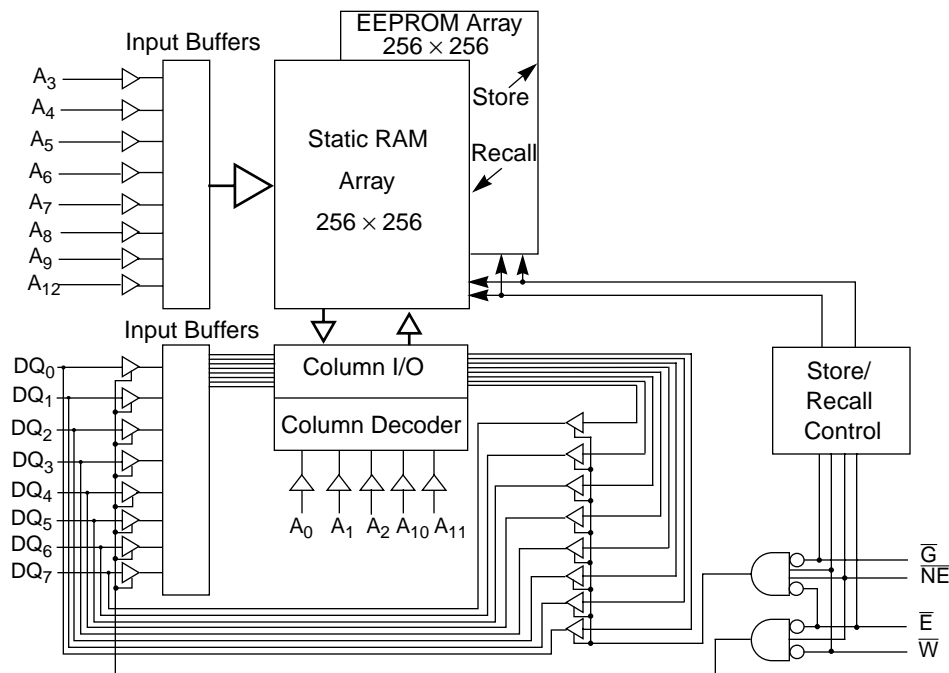


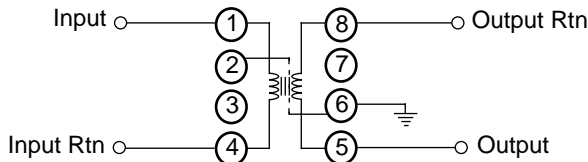
Figure 3-7 STK10C68 8 K x 8 nvSRAM

### 3.7 SC937-02 AES/EBU TRANSFORMER

The AES/EBU circuit incorporates a transformer to reject common mode interference while transmitting the signal with fast rise time and minimum aberration. The SC937-02 is a surface mount, low capacitance, wide-band AES/EBU transformer. The

### LCD Panel

SC937-02 has a very low capacitance shielded winding that reduces both radiated and received noise coupling and provides decreased jitter and improved audio quality, especially in noisy environments. EMI compliance and EMI susceptibility are improved by the use of this type of transformer. The transformer's ratio is 1:1, primary inductance is 600  $\mu$ H, inter-winding capacitance is 1.1 pF, bandwidth is 16 kHz to 100 MHz, and rise-time is 3 ns.



**Figure 3-8** SC937-02 AES/EBU Transformer

## 3.8 LCD PANEL

illustrates the different screens of the LCD panel and the corresponding actions of the soft switches.

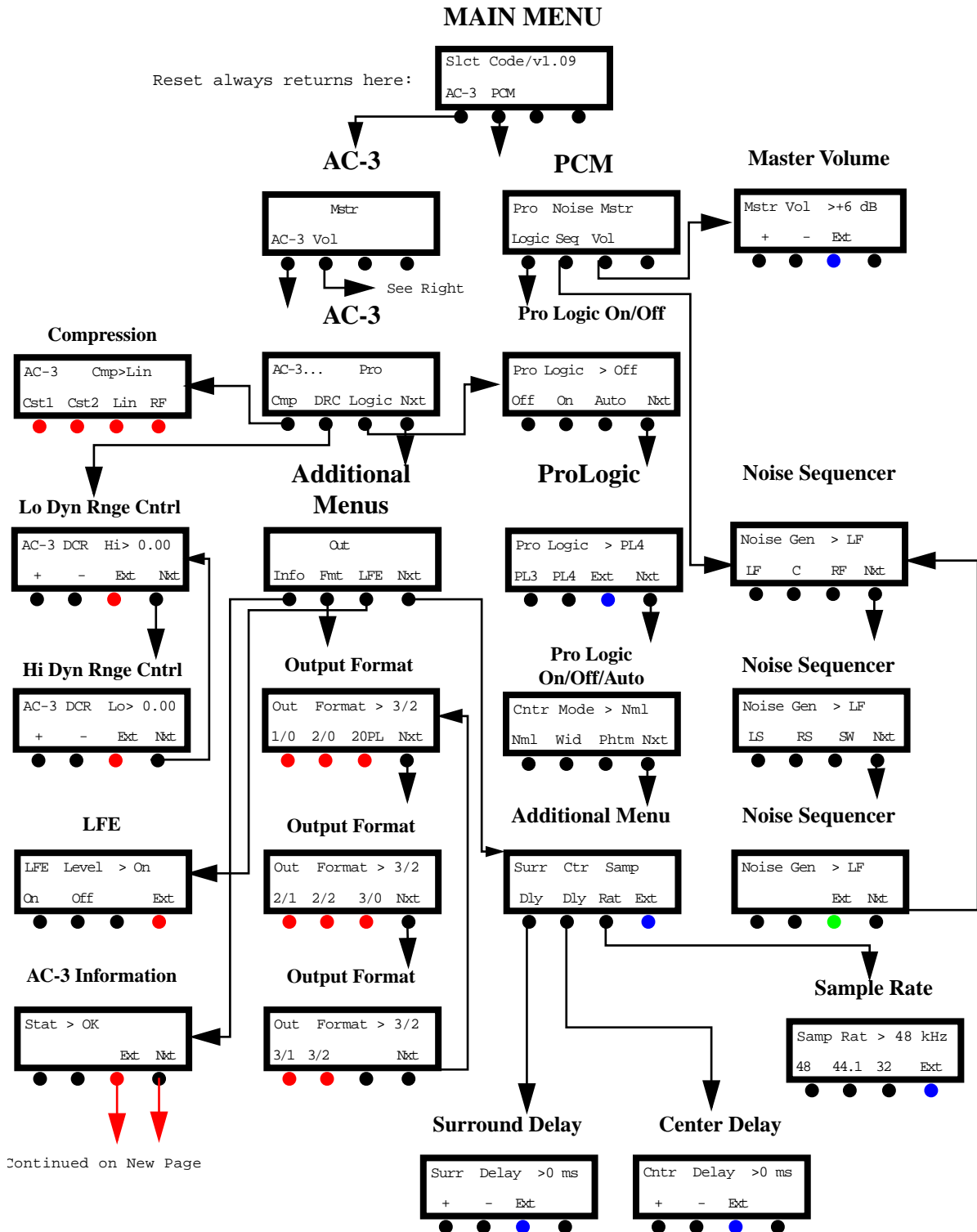
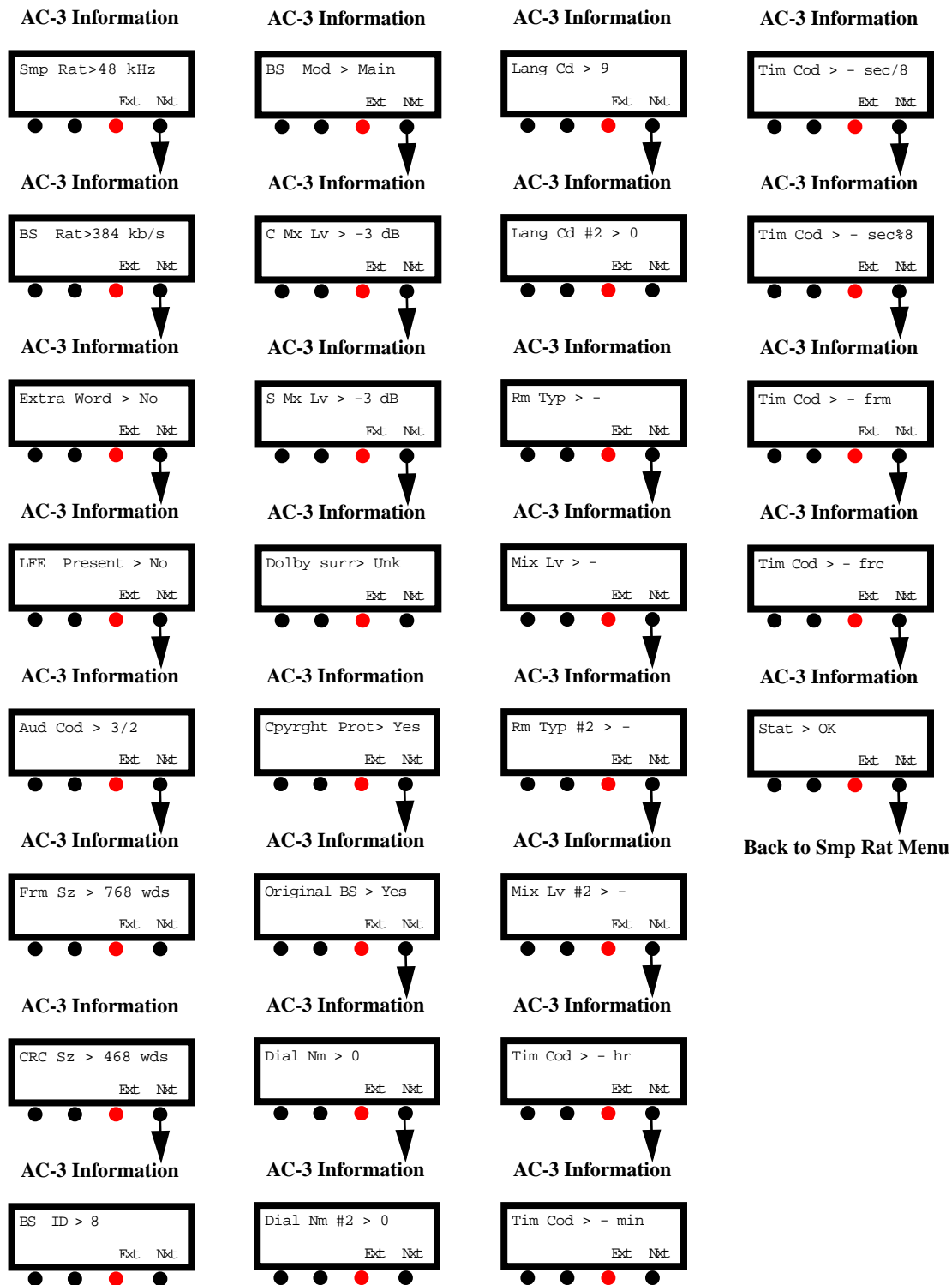


Figure 3-9 LCD Softswitch Screens

## LCD Panel



3.9 WIRING FOR KEYPAD

A wiring diagram for a generic keypad is shown in **Figure 3-10**. The keypad is not provided with the DSP56009EVM.

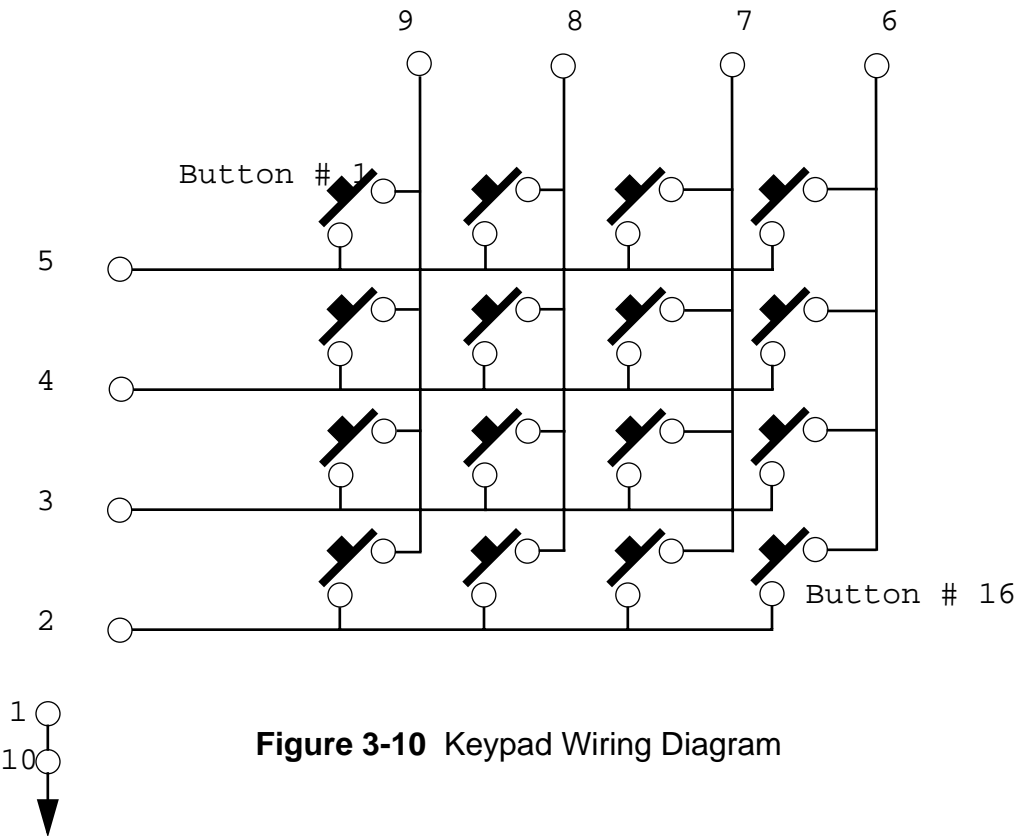


Figure 3-10 Keypad Wiring Diagram







# **SECTION 4**

## **DSP56009EVM SCHEMATICS**

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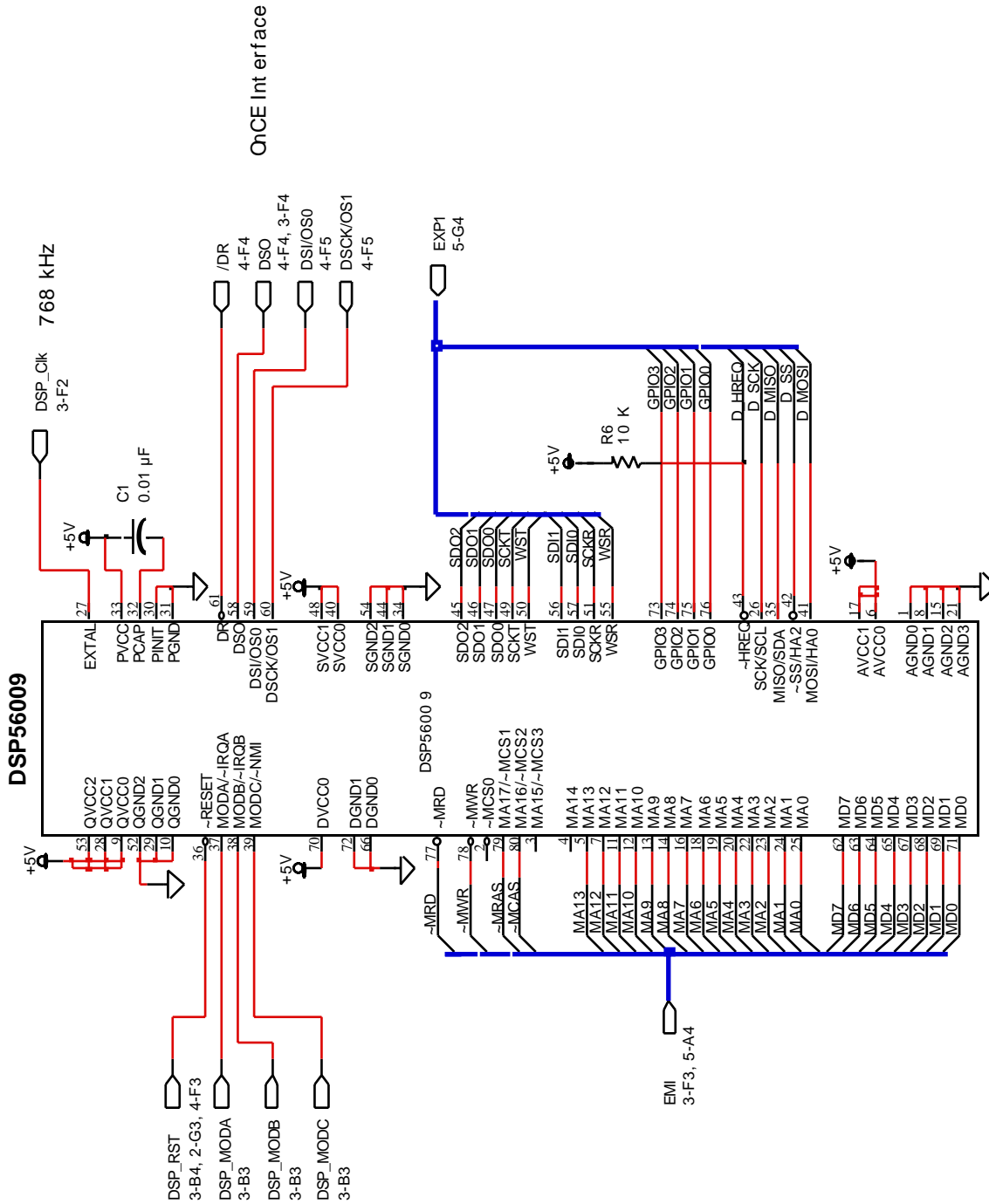


Figure 4-1 DSP56009

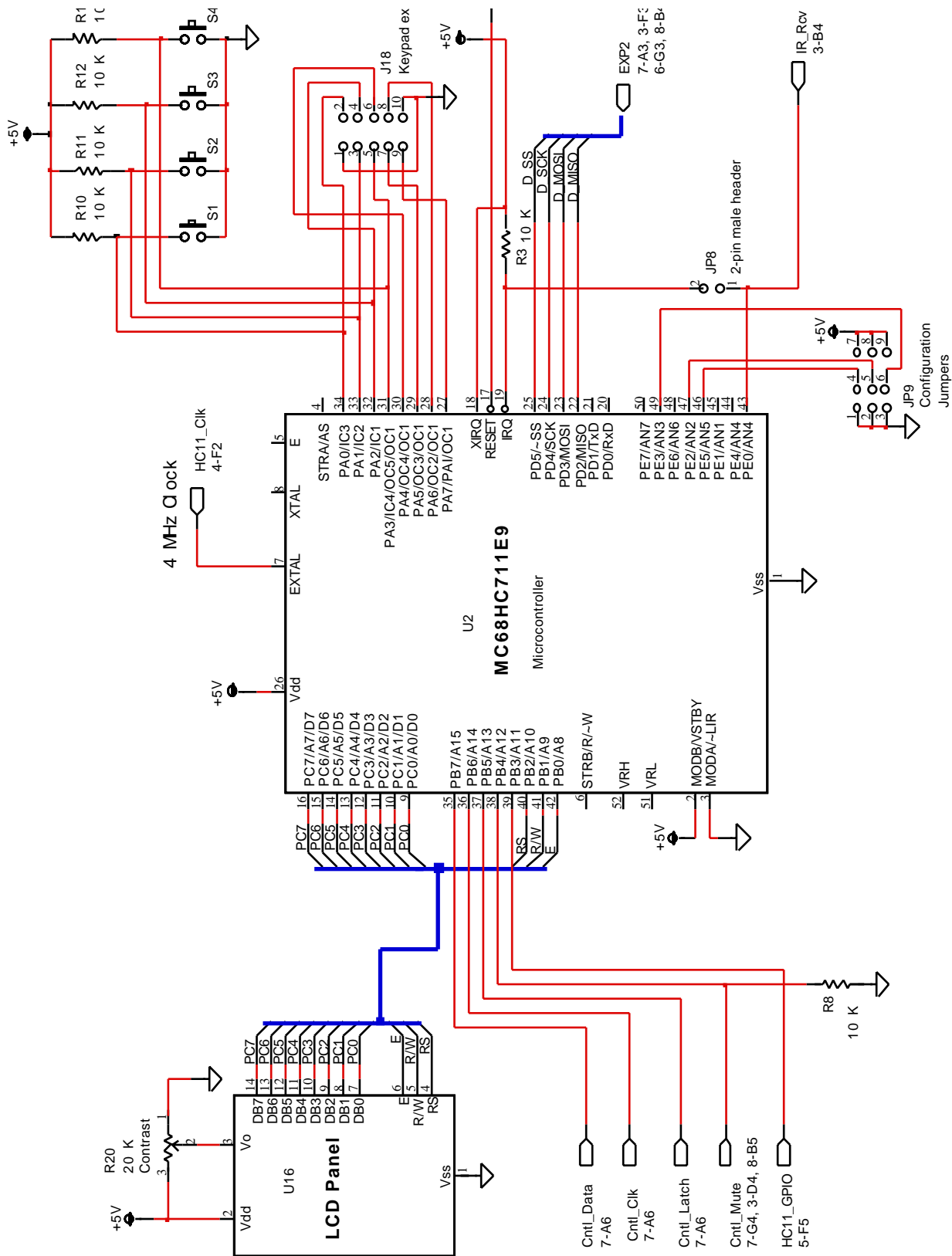
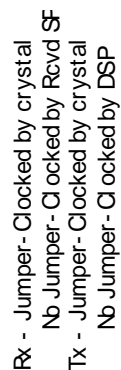
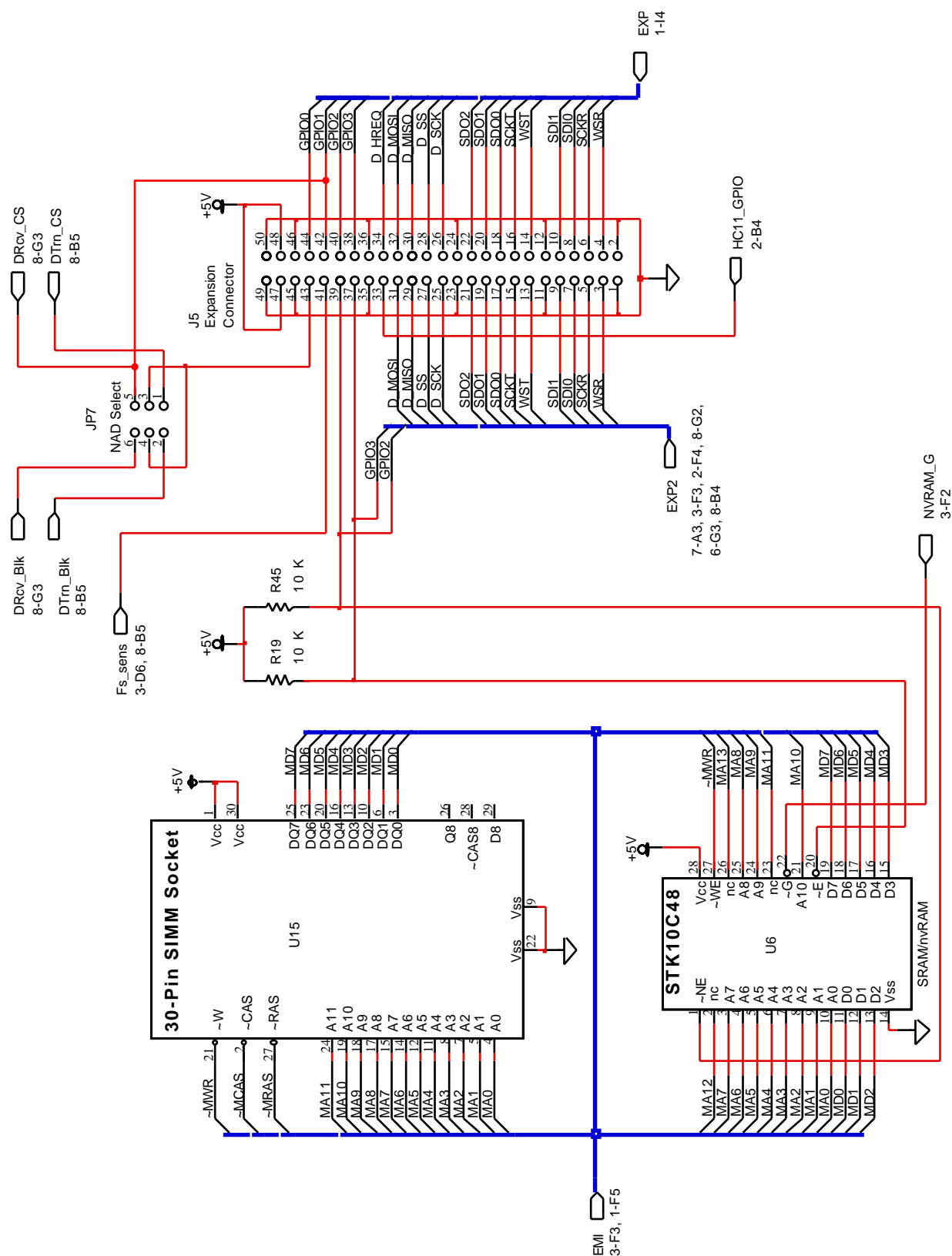


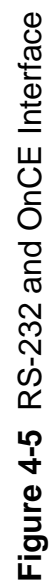
Figure 4-2 Microcontroller and LCD

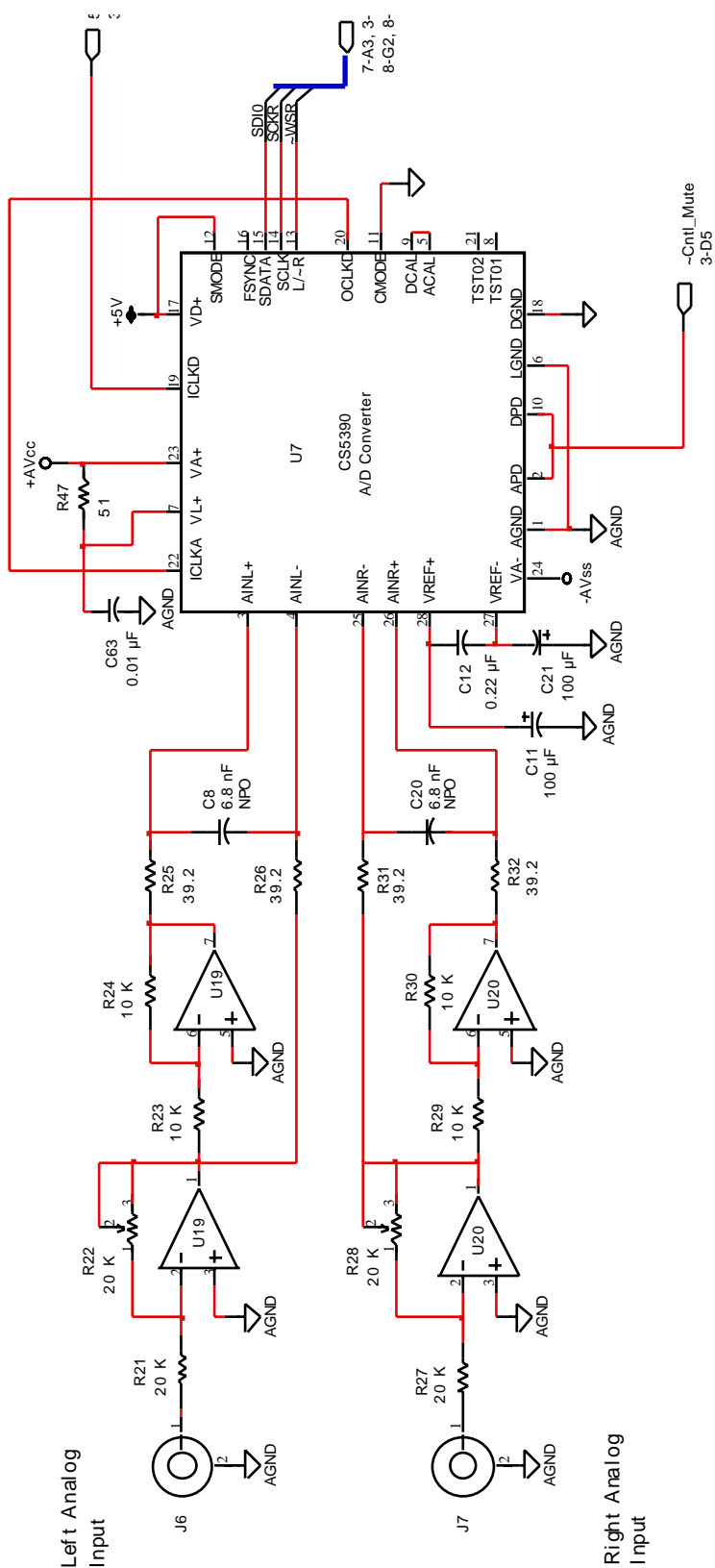


### Figure 4-3 Programmable Logic Device



### Figure 4-4 SRAM and External Memory Interface







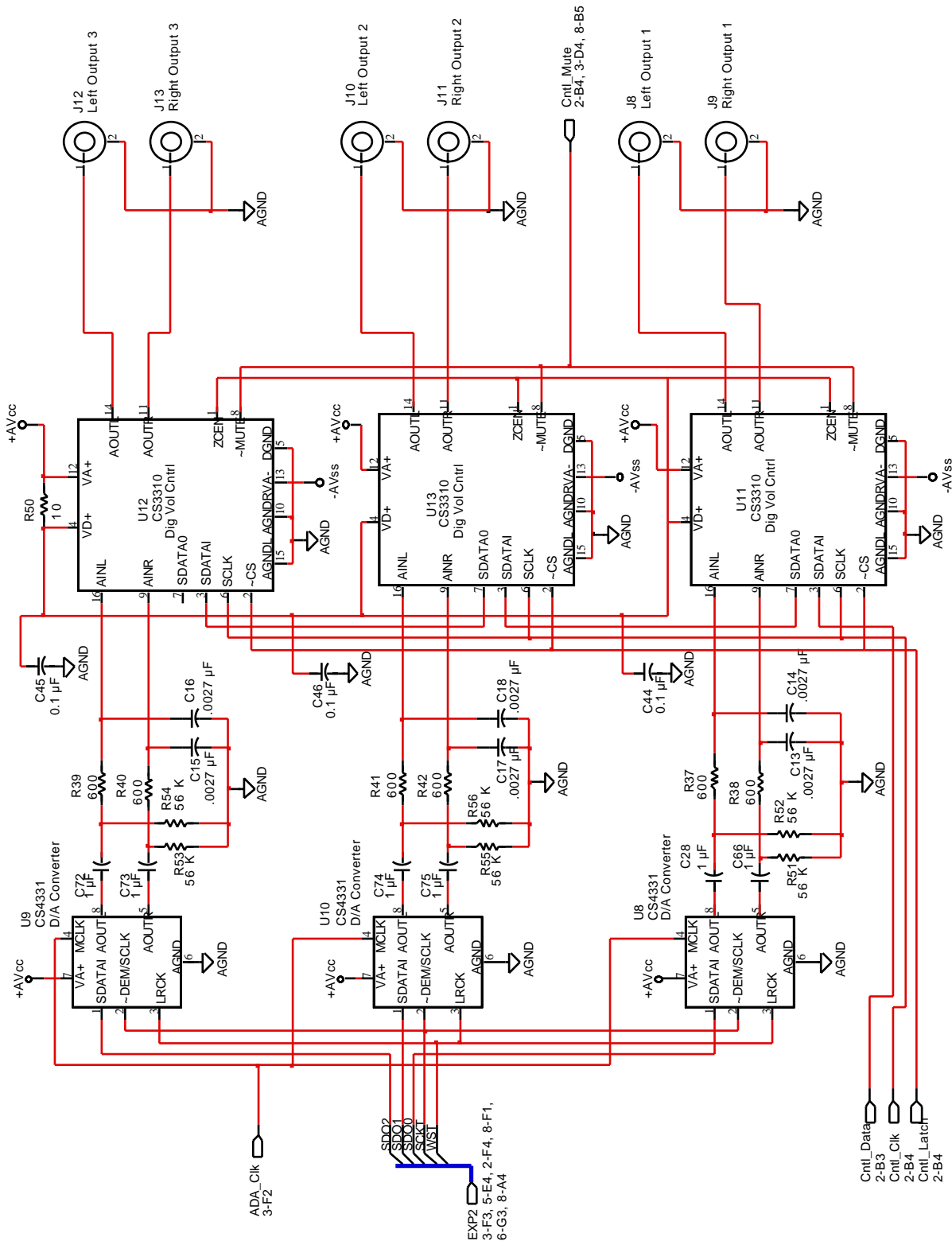


Figure 4-7 Digital-to-Analog Converter

SPDIF I/O

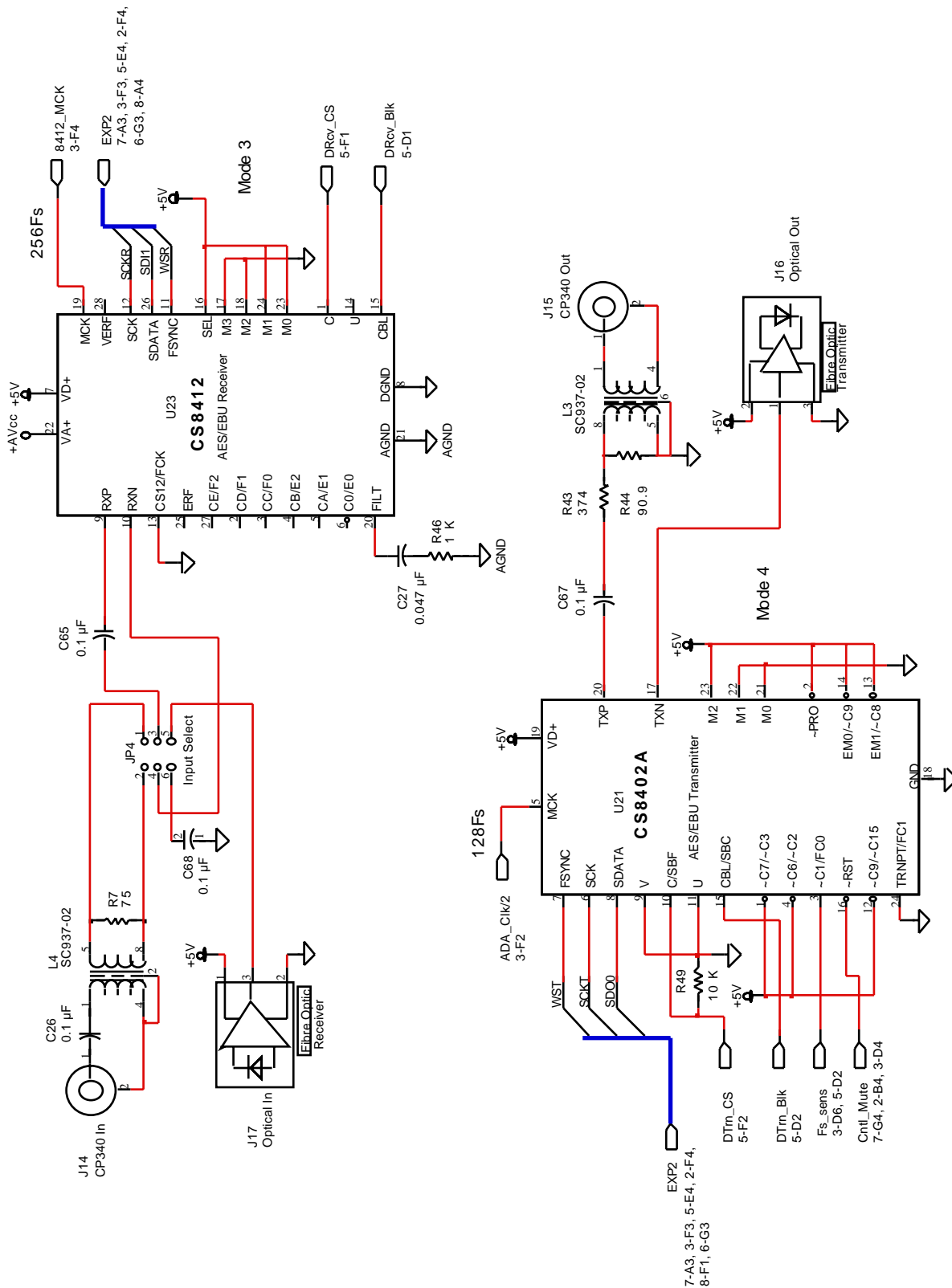
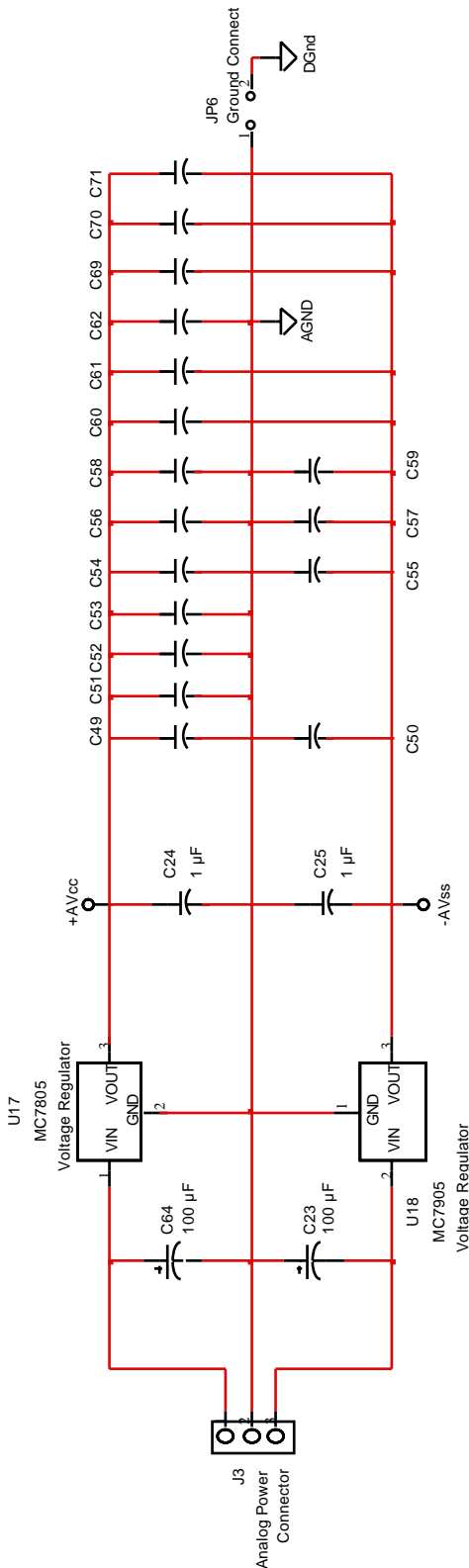
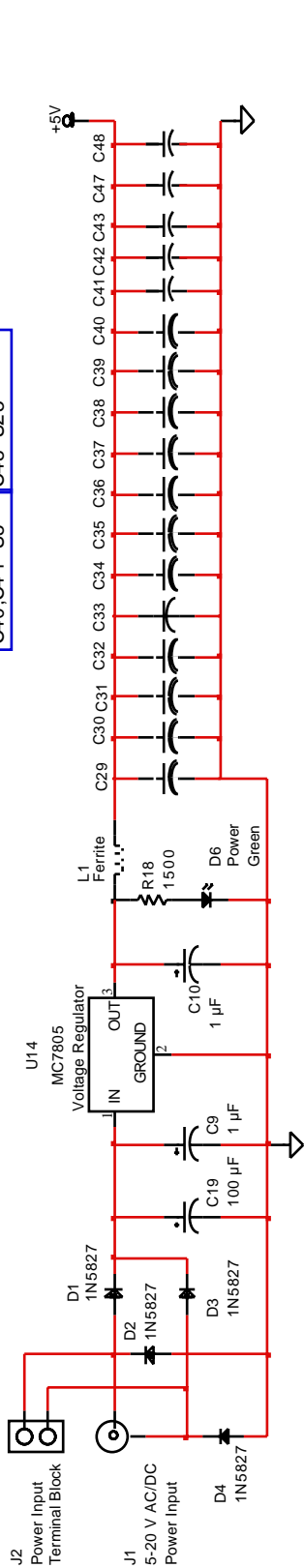


Figure 4-8 SPDIF I/O

Digital decoupling Caps —all 0.1 $\mu$ F unless otherwise noted	
C29-C37- U1	C42- U6
C38- U2	C43- U7
C39- U4	C47- U21
C40, C41- U5	C48- U23



Analog Decoupling Caps —all 0.1 $\mu$ F unless otherwise noted	
C49, C50- U7	C56, C57, C70- U12
C51- U8	C58, C59, C71- U13
C52- U9	C60- U19
C53- U10	C61- U20
C54, C55, C69- U11	C62- U23

Figure 4-9 Power Supply



# **SECTION 5**

## **DSP56009EVM PLD SPECIFICATION AND EVM PARTS LIST**

5.1	EPM7032 PLD SPECIFICATIONS . . . . .	5-55
5.1.1	PLD Schematics . . . . .	5-55
5.1.2	PLD Equations . . . . .	5-57
5.2	EVALUATION MODULE PARTS LIST . . . . .	5-60

## **5.1 EPM7032 PLD SPECIFICATIONS**

### **5.1.1 PLD Schematics**

The PLD schematic is illustrated on the following page in **Figure 5-1**.

EPM7032 PLD Specifications

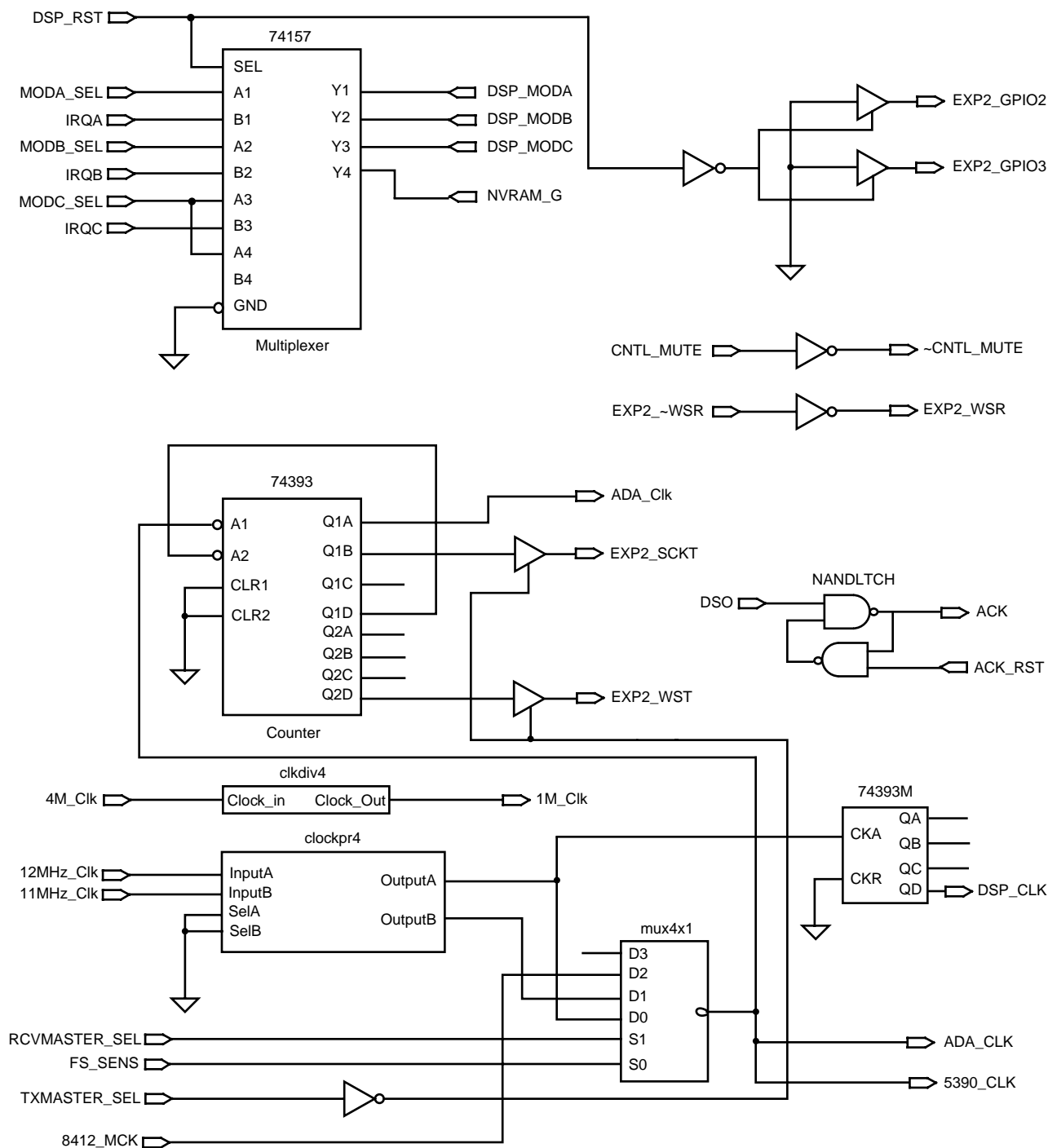


Figure 5-1 PLD Schematic



### 5.1.2 PLD Equations

The following data represents the PLD equations for the DSP56009EVM:

Device: EPM7032TC44

\*\*\*\*\*EQUATIONS\*\*\*\*\*

```

ACK_RST : INPUT;
CNTL_MUTE : INPUT;
DSO      : INPUT;
DSP_RST  : INPUT;
EMI_MRD  : INPUT;
EXP2_~WSR : INPUT;
FS_SENS  : INPUT;
IRQA     : INPUT;
IRQB     : INPUT;
IRQC     : INPUT;
MODA_SEL : INPUT;
MODB_SEL : INPUT;
MODC_SEL : INPUT;
RCVMASTER_SEL : INPUT;
TXMASTER_SEL : INPUT;
4M_Clk   : INPUT;
11MHZ_CLK : INPUT;
12MHZ_CLK : INPUT;
8412_MCK : INPUT;

```

```

% ACK    = _LC031 %
ACK      = LCELL( _EQ001 $ GND);
_EQ001   = _X001;
_X001    = EXP( DSO & _X002);
_X002    = EXP( ACK_RST & _X001);

```

```

% ADA_CLK = _LC006 %
ADA_CLK = LCELL( _EQ002 $ GND);
_EQ002   = FS_SENS & !RCVMASTER_SEL & 12MHZ_CLK
          # !FS_SENS & RCVMASTER_SEL & 8412_MCK
          # !FS_SENS & !RCVMASTER_SEL & 11MHZ_CLK;

```

**EPM7032 PLD Specifications**

```
% ADA_Clk/2 = _LC019 %
% ADA_Clk/2 = |74393:15|Q1A %
ADA_Clk/2 = TFFE( VCC, _EQ003, VCC, VCC, VCC);
_EQ003 = _X003 & _X004 & _X005;
_X003 = EXP(!FS_SENS & RCVMASTER_SEL & 8412_MCK);
_X004 = EXP( FS_SENS & !RCVMASTER_SEL & 12MHZ_CLK);
_X005 = EXP(!FS_SENS & !RCVMASTER_SEL & 11MHZ_CLK);

% DSP_CLK = _LC020 %
% DSP_CLK = |74393m:82|QD %
DSP_CLK = TFFE( _EQ004, !12MHZ_CLK, VCC, VCC, VCC);
_EQ004 = _LC009 & _LC014 & _LC027;

% DSP_MODA = _LC010 %
DSP_MODA = LCELL( _EQ005 $ GND);
_EQ005 = DSP_RST & IRQA
        # !DSP_RST & MODA_SEL;

% DSP_MODB = _LC011 %
DSP_MODB = LCELL( _EQ006 $ GND);
_EQ006 = DSP_RST & IRQB
        # !DSP_RST & MODB_SEL;

% DSP_MODC = _LC012 %
DSP_MODC = LCELL( _EQ007 $ GND);
_EQ007 = DSP_RST & IRQC
        # !DSP_RST & MODC_SEL;

% EXP2_GPIO2 = _LC016 %
EXP2_GPIO2 = TRI(_LC016, GLOBAL(!DSP_RST));
_LC016 = LCELL( GND $ GND);

% EXP2_GPIO3 = _LC021 %
EXP2_GPIO3 = TRI(_LC021, GLOBAL(!DSP_RST));
_LC021 = LCELL( GND $ GND);

% EXP2_SCKT = |74393:15|Q1B %
EXP2_SCKT = TRI(_LC002, GLOBAL(!TXMASTER_SEL));
_LC002 = TFFE( ADA_Clk/2, _EQ008, VCC, VCC, VCC);
_EQ008 = _X003 & _X004 & _X005;

% EXP2_WSR = _LC003 %
EXP2_WSR = LCELL(!EXP2_~WSR $ GND);
```

```
% EXP2_WST = |74393:15|Q2D %
EXP2_WST = TRI(_LC017, GLOBAL(!TXMASTER_SEL));
_LC017 = TFFE(_EQ009, !_LC007, VCC, VCC, VCC);
_EQ009 = _LC004 & _LC013 & _LC026;

% NVRAM_G = _LC001 %
NVRAM_G = LCELL(_EQ010 $ GND);
_EQ010 = DSP_RST & EMI_MRD
        # !DSP_RST & MODC_SEL;

% 1M_Clk = _LC025 %
% 1M_Clk = |clkdiv4:116|Clock_Out %
1M_Clk = TFFE(VCC, _LC024, VCC, VCC, VCC);

% 5390_CLK = _LC023 %
5390_CLK = LCELL(_EQ011 $ GND);
_EQ011 = FS_SENS & !RCVMASTER_SEL & 12MHZ_CLK
        # !FS_SENS & RCVMASTER_SEL & 8412_MCK
        # !FS_SENS & !RCVMASTER_SEL & 11MHZ_CLK;

% |clkdiv4:116|:1 %
_LC024 = TFFE(VCC, 4M_Clk, VCC, VCC, VCC);

% |74393:15|Q1C = |74393:15|:5 %
_LC005 = TFFE(_EQ012, _EQ013, VCC, VCC, VCC);
_EQ012 = ADA_Clk/2 & _LC002;
_EQ013 = _X003 & _X004 & _X005;

% |74393:15|Q1D = |74393:15|:9 %
_LC007 = TFFE(_EQ014, _EQ015, VCC, VCC, VCC);
_EQ014 = ADA_Clk/2 & _LC002 & _LC005;
_EQ015 = _X003 & _X004 & _X005;

% |74393:15|Q2A = |74393:15|:28 %
_LC004 = TFFE(VCC, !_LC007, VCC, VCC, VCC);

% |74393:15|Q2B = |74393:15|:29 %
_LC013 = TFFE(_LC004, !_LC007, VCC, VCC, VCC);

% |74393:15|Q2C = |74393:15|:30 %
_LC026 = TFFE(_EQ016, !_LC007, VCC, VCC, VCC);
_EQ016 = _LC004 & _LC013;
```

**Evaluation Module Parts List**

```

% |74393m:82|QA = |74393m:82|:1 %
_LC014 = TFFE( VCC, !12MHZ_CLK, VCC, VCC, VCC);

% |74393m:82|QB = |74393m:82|:3 %
_LC009 = TFFE( _LC014, !12MHZ_CLK, VCC, VCC, VCC);

% |74393m:82|QC = |74393m:82|:5 %
_LC027 = TFFE( _EQ017, !12MHZ_CLK, VCC, VCC, VCC);
_EQ017 = _LC009 & _LC014;

% ~CNTL_MUTE = _LC029 %
~CNTL_MUTE = LCELL(!CNTL_MUTE $ GND);

```

## 5.2 EVALUATION MODULE PARTS LIST

The following four pages contain, in table form, information on the parts and devices on the Evaluation Module. Contact information for suppliers of key devices, as indicated by footnote, is also included at the end of the table.

**Table 5-1** DSP56009EVM Parts List

Part Designator	Manufacturer	Part Number	Description
U1	Motorola	DSP56009	DSP
U2	Motorola	MC68HC711E9	Microcontroller
U24	Motorola	MC68HC705K1	Microcontroller (OnCE)
U7	Crystal <sup>a</sup>	CS5390-KS	ADC
U8 U9 U10	Crystal <sup>a</sup>	CS4331-KS	DAC
U21	Crystal <sup>a</sup>	CS8402-CS	AES/EBU Transmitter
U23	Crystal <sup>a</sup>	CS8412-CS	AES/EBU Receiver
U11 U12 U13	Crystal <sup>a</sup>	CS3310-KS	Digital Volume Controller

**Evaluation Module Parts List**

Part Designator	Manufacturer	Part Number	Description
L3 L4	Scientific Conversion <sup>b</sup>	SC937-02	Audio Isolation Transformer
U6	Simtek <sup>c</sup>	STK1068-S45	SRAM/nVRAM
U16	Hitachi	LM052L	LCD Module
U14 U17	Motorola	MC7805	Voltage Regulator
U18	Motorola	MC7905	Voltage Regulator
U19 U20	Motorola	MC33078	Op-Amp
U5	Altera	EPM7032TC44-12	PLD
D1 D2 D3 D4 D7	Rectron	FM4001	Rectifier, SMD
U4	Maxim	MAX232CSE	RS232 Transceiver
C4 C5 C6 C7 C9 C10 C22 C24 C25	Murata	GRM42-6Y5V105Z16BL	1.0 $\mu$ F capacitor
C28 C66 C72 C73 C74 C75	TDK	CC1206CY5V335ZTR	3.3 $\mu$ F capacitor
C1 C63	Murata	GRM42-6XR103K050BD	0.01 $\mu$ F capacitor
C8 C20	Venkel	C1210C0G500-682JNE	6.8 nF capacitor
C11 C19 C21 C23 C64	Future	SME25T101M6X16LL	100 $\mu$ F Aluminum Electrolytic capacitor
C2 C3	Murata	GRM42-6C0G470J050BD	47 pF capacitor
C26 C29 C30 C31 C33 C34 C35 C36 C37 C38 C39 C40 C41 C42 C43 C44 C45 C46 C47 C48 C49 C50 C51 C52 C53 C54 C55 C56 C57 C58 C59 C60 C61 C62 C65 C67 C68 C69 C70 C71	Murata	GRM42-6X7R104K050BL	0.1 $\mu$ F capacitor
C27	Venkel	C1206X7R500-473KNE	0.047 $\mu$ F capacitor
C13 C14 C15 C16 C17 C18	Venkel	C1206X7R500-272KNE	0.0027 $\mu$ F capacitor
C12	Venkel	C1206X7R500-224KNE	0.22 $\mu$ F capacitor

**Evaluation Module Parts List**

Part Designator	Manufacturer	Part Number	Description
R50			10 $\Omega$ 1/4W resistor
R25 R26 R31 R32	Venkel	CR1206-8W-39R2FT	39.2 $\Omega$ 1/4W resistor
R47	Venkel	CR1206-8W-51R1FT	51 $\Omega$ 1/4W resistor
R7			75 $\Omega$ 1/4W resistor
R44	Venkel	CR1206-8W-90R9FT	90.9 $\Omega$ 1/4W resistor
R43	Venkel	CR1206-8W-3740FT	374 $\Omega$ 1/4W resistor
R37 R38 R39 R40 R41 R42	Future	NRC12F604OTR	604 $\Omega$ 1/4W resistor
R46	Future	CRCW1206-102JRT1	1.0 K $\Omega$ 1/4W resistor
R16 R18	Newark	44F6300-1.5K	1.5 K $\Omega$ 1/4W resistor
R1 R2 R3 R4 R5 R6 R8 R9 R10 R11 R12 R13 R14 R15 R17 R19 R23 R24 R29 R30 R45 R48 R49 R57	Future	CR32-1002F-T	10 K $\Omega$ 1/4W resistor
R21 R27			20 k $\Omega$ 1/4W resistors
R51 R52 R53 R54 R55 R56			56 k $\Omega$ 1/4W resistors
R20 R22 R28	Digikey	D4AA24-ND	20 k $\Omega$ 1/4W trimpot thru-hole
Y1	MMD	MB100HA-11.2896MHz	11.2896 MHz Clock Oscilla- tor
Y2	MMD	MB100HA-12.288MHz	12.288 MHz Clock Oscilla- tor
Y3	Ecliptek	EC2-040-4.000MHz-I	4.0 MHz Crystal
JP2 JP6 JP8			2-pin single row header
J19			4-pin single row header
JP1 JP5			4-pin double row header
JP3 JP4 JP7			6-pin double row header
J18			10-pin double row header

**Evaluation Module Parts List**

<b>Part Designator</b>	<b>Manufacturer</b>	<b>Part Number</b>	<b>Description</b>
on PC board for U16			14-pin single row female header
on PC board for U16			14-pin single row male header
J5			50-pin double row male header
on PC board for U15			SIMM socket
J17	Sharp	GP1F32R	Optical Connector-Receive
J16	Sharp	GP1F32T	Optical Connector-Transmit
J1	Mouser	16PJ031	2.1 mm DIN power connector
J4	Mouser	152-3409	PC mount DB9 female connector
J7 J9 J11 J13 J6 J8 J10 J13 J14 J15	Mouser	161-4215	RCA Jack
on PC board for U2	McKensie	PLCC-52P-T	52-pin PLCC socket
J2			2-position terminal block
J3			3-position terminal block
S1 S2 S3 S4 S5			6mm pushbutton switch
D6	Future	HLMP1790	Green LED 2 mA, 1.8 V
D5	Future	HLMP1700	Red LED 2 mA, 1.8 V
U22	Sharp	GP1U56Y	Infrared receiver
L1	Future	BL01RN1-A62	Ferrite
on PC board for U14			TO-220 0.5" compact heat sink

a.Crystal Semiconductor Corporation, P.O. Box 17847, Austin, TX 78760, (512) 445-7222 Fax: (512) 462-2723

b.Scientific Conversion, Inc., 42 Truman Drive, Novato, CA 94947,(415) 892-2323, Fax: (415) 892-2321

c.Simtek Corporation, 1465 Kelly Johnson Blvd., Colorado Springs, CO 80920, (800) 637-1667, Fax: (719) 531-9481





# **SECTION 6**

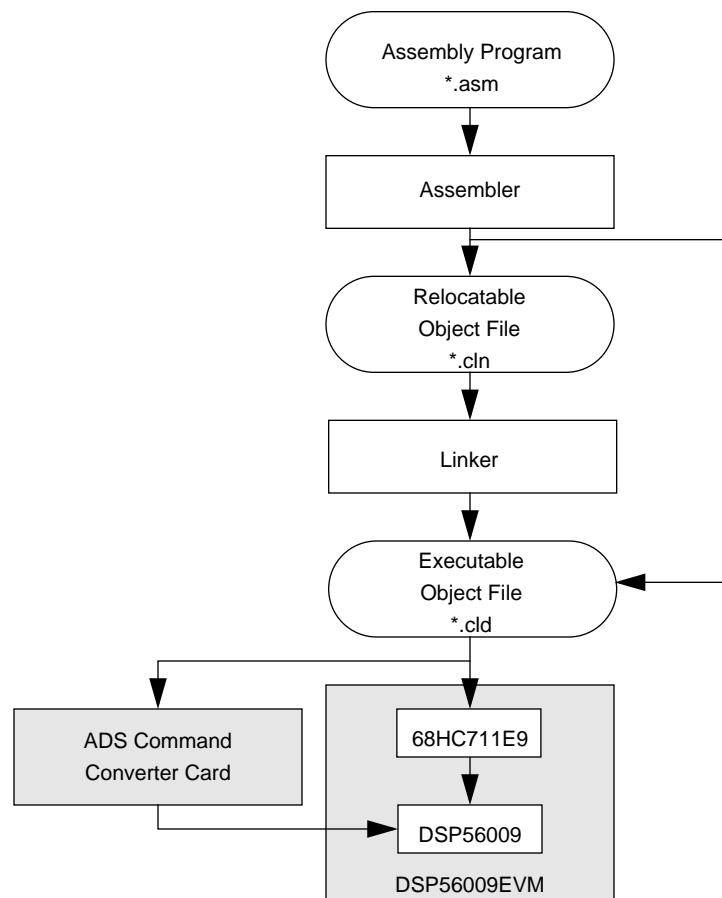
## **EXAMPLE TEST PROGRAM**

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## 6.1 OVERVIEW

This section contains an example that illustrates how to develop a very simple program for the DSP56009. This example has been designed for users who have little or no experience with the DSP development tools. The example demonstrates the form of assembly programs, gives instructions on how to assemble programs, and shows how the Debugger can be used to verify the operation of programs.

The rounded blocks represent the assembly and object files. The white blocks represent software programs to assemble and link the assemble programs. The gray blocks represent hardware products. The following sections give basic information regarding the assembly program, the Assembler, the Linker and the object files. Detailed information about these subjects can be found in the Assembler and Linker manuals provided with the Motorola DSP CLAS software package, available through your Motorola sales office or distributor. The documentation is also available through the Motorola DSP internet URL <http://www.motorola-dsp.com>.



**Figure 6-1** Development Process Flow

## 6.2 WRITING THE PROGRAM

The following sections describe the format of assembly language source statements and give an example assembly program.

### 6.2.1 Source Statement Format

Programs written in assembly language consist of a sequence of source statements. Each source statement may include up to six fields separated by one or more spaces or tabs: a label field, an operation field, an operand field, up to two data transfer fields, and a comment field. For example, the following source statement shows all six possible fields:

trm	mac	x0,y0,a	x:(r0)+,x0	y:(r4)+,y0	;Text
↑	↑	↑	↑	↑	↑
Label	Operation	Operand	X Data Transfer	Y Data Transfer	Comment

#### 6.2.1.1 Label Field

The label field is the first field of a source statement and can take one of the following forms:

- A space or tab as the first character on a line ordinarily indicates that the label field is empty and that the line has no label.
- An alphabetic character as the first character indicates that the line contains a symbol called a label.
- An underscore as the first character indicates that the label is a local label.

With the exception of some directives, a label is assigned the value of the location counter of the first word of the instruction or data being assembled. A line consisting of a label only is a valid line and has the effect of assigning the value of the location counter to the label.

#### 6.2.1.2 Operation Field

The operation field appears after the label field and must be preceded by at least one space or tab. Entries in the operation field may be one of three types:

- **Opcode**—mnemonics that correspond directly to DSP machine instructions
- **Directive**—special operation codes known to the Assembler which control the assembly process

- **Macro call**—invocation of a previously defined macro which is to be inserted in place of the macro call

#### **6.2.1.3 Operand Field**

The interpretation of the operand field is dependent on the contents of the operation field. The operand field, if present, must follow the operation field and must be preceded by at least one space or tab.

#### **6.2.1.4 Data Transfer Fields**

Most opcodes can specify one or more data transfers to occur during the execution of the instruction. These data transfers are indicated by two addressing mode operands separated by a comma, with no embedded blanks. If two data transfers are specified, they must be separated by one or more blanks or tabs. Refer to the DSP56000 Family Manual for a complete discussion of addressing modes that are applicable to data transfer specifications.

#### **6.2.1.5 Comment Field**

Comments are not considered significant to the Assembler, but can be included in the source file for documentation purposes. A comment field is composed of any characters that are preceded by a semicolon.

### **6.2.2 Example Program**

This program takes two lists of data, one in X memory, and one in Y memory, and calculates the sum of the products of the two lists. Calculating the sum of products is the basis for many DSP functions. Therefore, the DSP56009 has a special instruction (MAC) that multiplies two values and adds the result to the contents of an accumulator. This program is provided as example.asm on the DSP56009EVM demos diskette and is placed in the EVM56007 directory by the installation procedure.

#### Example 6-1 Simple DSP56009 Code Example

```
;*****
;A SIMPLE PROGRAM: CALCULATING THE SUM OF PRODUCTS
;*****
PBASE      EQU      $100      ;instruct the assembler to replace
                                ;every occurrence of PBASE with $200
XBASE      EQU      $0        ;used to define the position of the
                                ;data in X memory
YBASE      EQU      $0        ;used to define the position of the
                                ;data in Y memory
;*****
;X MEMORY
;*****
                org      x:XBASE ;instructs the assembler that we
                                ;are referring to X memory starting
                                ;at location XBASE
list1        dc      $475638,$738301,$92673a,$898978,$091271,$f25067
                dc      $987153,$3A8761,$987237,$34b852,$734623,$233763
                dc      $f76756,$423423,$324732,$f40029
;*****
;Y MEMORY
;*****
                org      y:YBASE ;instructs the assembler that we
                                ;are referring to Y memory starting
                                ;at location YBASE
list2        dc      $f98734,$800000,$fedcba,$487327,$957572,$369856
                dc      $247978,$8a3407,$734546,$344787,$938482,$304f82
                dc      $123456,$657784,$567123,$675634
;*****
;PROGRAM
;*****
                org      p:0      ;put following program in program
                                ;memory starting at location 0
                jmp      begin    ;p:0 is the reset vector i.e. where
                                ;the DSP looks for instructions
                                ;after a reset
                org      p:PBASE  ;start the main program at p:PBASE

begin
                move     #list1,r0 ;set up pointer to start of list1
                move     #list2,r4 ;set up pointer to start of list2
                clr      a        ;clear accumulator a
                move     x:(r0)+,x0 y:(r4)+,y0
                                ;load the value of X memory pointed
                                ;to by the contents of r0 into x0 and
                                ;post-increment r0
                                ;load the value of Y memory pointed
                                ;to by the contents of r4 into y0 and
                                ;post-increment r4
```

---

**Example 6-1** Simple DSP56009 Code Example (Continued)

---

```
do          #15,endloop ;do 15 times
mac         x0,y0,a      x:(r0)+,x0    y:(r4)+,y0
                        ;multiply and accumulate, and load
                        ;next values
endloop     jmp          *            ;this is equivalent to
                        ;label jmp label
                        ;and is therefore a never-ending,
                        ;empty loop
;*****
;END OF THE SIMPLE PROGRAM
;*****
```

---

## 6.3 ASSEMBLING THE PROGRAM

The following sections describe the format of the Assembler command, give a list of Assembler special characters and directives, and give instructions to assemble the example program.

### 6.3.1 Assembler Command Format

The Motorola DSP Assembler is included with the DSP56009EVM on the Motorola 3-1/2 inch diskette and can be installed by following the instructions in **Section 1.4.3**. The Motorola DSP Assembler is a program that translates assembly language source statements into object programs compatible with the DSP56009. The general format of the command line to invoke the Assembler is:

***asm56000***[*options*] <*filenames*>

where ***asm56000*** is the name of the Motorola DSP Assembler program, and <*filenames*> is a list of the assembly language programs to be assembled. The following section describes the Assembler options. To avoid ambiguity, the option arguments should immediately follow the option letter with no blanks between them.

### 6.3.2 Assembler Options

#### **-A**

This option indicates that the Assembler should run in Absolute mode, generating an absolute object file when the **-B** command line option is given. By default, the Assembler produces a relocatable object file that is subsequently processed by the Motorola DSP Linker.

#### **-B<objfil>**

This option specifies that an object file is to be created for Assembler output. <objfil> can be any legal operating system filename, including an optional pathname. The type of object file produced depends on the Assembler operation mode. If the **-A** option is supplied on the command line, the Assembler operates in Absolute mode and generates an absolute object (.cld) file. If there is no **-A** option on the command line, the Assembler operates in Relative mode and creates a relocatable object (.cln) file. If the **-B** option is not specified, the Assembler will not generate an object file. If no <objfil> is specified, the Assembler will use the basename (filename without extension) of the first filename encountered in the source input file list and append the appropriate file type (.cln or .cld) to the basename. The **-B** option should be specified only once.

Example: **asm56000 -Bfilter main.asm fft.asm fio.asm**

This example assembles the files main.asm, fft.asm, and fio.asm together to produce the relocatable object file filter.cln.

#### **-D <symbol> <string>**

This option replaces all occurrences of <symbol> with <string> in the source files to be assembled.

Example: **asm56000 -DPOINTS 16 prog.asm**

This example replaces all occurrences of the symbol POINTS in the program prog.asm by the string '16'.

#### **-EA<errfil> or -EW<errfil>**

These options allow the standard error output file to be reassigned on hosts that do not support error output redirection from the command line. <errfil> must be present as an argument, but can be any legal operating system filename, including an



optional pathname. The **-EA** option causes the standard error stream to be written to `<errfil>`; if `<errfil>` exists, the output stream is appended to the end of the file. The **-EW** option also writes the standard error stream to `<errfil>`; if `<errfil>` exists, it will be overwritten.

Example: ***asm56000 -EWerrors prog.asm***

This example redirects the standard output to the file errors. If the file already exists, it will be overwritten.

### **-F<argfil>**

This option indicates that the Assembler should read command line input from `<argfil>`. `<argfil>` can be any legal operation system filename, including an optional pathname. `<argfil>` is a text file containing further options, arguments, and filenames to be passed to the Assembler. The arguments in the file need to be separated only by some form of white space. A semicolon on a line following white space makes the rest of the line a comment.

Example: ***asm56000 -Fopts.cmd***

This example invokes the Assembler and takes the command line options and source filenames from the command file `opts.cmd`.

### **-G**

This option sends the source file line number information to the object file. This option is valid only in conjunction with the **-B** command line option. The generated line number information can be used by debuggers to provide source-level debugging.

Example: ***asm56000 -B -Gmyprog.asm***

This example assembles the file `myprog.asm` and sends the source file line number information to the resulting object file `myprog.cln`.

### **-I<pathname>**

This option causes the Assembler to look in the directory defined by `<pathname>` for any include file not found in the current directory. `<pathname>` can be any legal operating system pathname.

Example: ***asm56000 -I\project\ testprog***

### Assembling the Program

This example uses IBM PC pathname conventions, and would cause the Assembler to prefix any include files not found in the current directory with the \project\ pathname.

#### **-L<lstfil>**

This option specifies that a listing file is to be created for Assembler output. <lstfil> can be any legal operating system filename, including an optional pathname. If no <lstfil> is specified, the Assembler will use the basename (filename without extension) of the first filename encountered in the source input file list and append .lst to the basename. The -L option should be specified only once.

Example: ***asm56000 -L filter.asm gauss.asm***

This example assembles the files filter.asm and gauss.asm together to produce a listing file. Because no filename was given, the output file will be named using the basename of the first source file, in this case filter, and the listing file will be called filter.lst.

#### **-M<pathname>**

This option causes the Assembler to look in the directory defined by <pathname> for any macro file not found in the current directory. <pathname> can be any legal operating system pathname.

Example: ***asm56000 -Mfftlb\ trans.asm***

This example uses IBM PC pathname conventions, and would cause the Assembler to look in the fftlib subdirectory of the current directory for a file with the name of the currently invoked macro found in the source file, trans.asm.

#### **-V**

This option causes the Assembler to report assembly progress to the standard error output stream.

#### **-Z**

This option causes the Assembler to strip symbol information from the absolute load file. Normally symbol information is retained in the object file for symbolic references purposes. This option is only valid with the -A and -B options.

**Note:** Multiple options can be used. A typical string might be:

Example: ***asm56000 -A -B -L -Z filename.asm***

### 6.3.3 Assembler Directives

In addition to the DSP56009 instruction set, the assembly programs can contain mnemonic directives that specify auxiliary actions to be performed by the Assembler. These are the Assembler directives. These directives are not always translated into machine language. The following sections briefly describe the various types of Assembler directives.

#### 6.3.3.1 Assembler Significant Characters

There are several one and two character sequences that are significant to the Assembler. The Assembler significant characters are:

;	- Comment delimiter
::	- Unreported comment delimiter
\	- Line continuation character or macro dummy argument concatenation operator
?	- Macro value substitution operator
%	- Macro hex value substitution operator
^	- Macro local label override operator
“	- Macro string delimiter or quoted string DEFINE expansion character
@	- Function delimiter
*	- Location counter substitution
++	- String concatenation operator
[]	- Substring delimiter
<<	- I/O short addressing mode force operator
<	- Short addressing mode force operator
>	- Long addressing mode force operator
#	- Immediate addressing mode operator
#<	- Immediate short addressing mode force operator
#>	- Immediate long addressing mode force operator

Assembling the Program

**6.3.3.2 Assembly Control**

The directives used for assembly control are:

<b>COMMENT</b>	- Start comment lines
<b>DEFINE</b>	- Define substitution string
<b>END</b>	- End of source program
<b>FAIL</b>	- Programmer generated error message
<b>FORCE</b>	- Set operand forcing mode
<b>HIMEM</b>	- Set high memory bounds
<b>INCLUDE</b>	- Include secondary file
<b>LOMEM</b>	- Set low memory bounds
<b>MODE</b>	- Change relocation mode
<b>MSG</b>	- Programmer generated message
<b>ORG</b>	- Initialize memory space and location counters
<b>RADIX</b>	- Change input radix for constants
<b>RDIRECT</b>	- Remove directive or mnemonic from table
<b>SCSJMP</b>	- Set structured control branching mode
<b>SCSREG</b>	- Reassign structured control statement registers
<b>UNDEF</b>	- Undefine DEFINE symbol
<b>WARN</b>	- Programmer generated warning

### 6.3.3.3 Symbol Definition

The directives used to control symbol definition are:

<b>ENDSEC</b>	- End section
<b>EQU</b>	- Equate symbol to a value
<b>GLOBAL</b>	- Global section symbol declaration
<b>GSET</b>	- Set global symbol to a value
<b>LOCAL</b>	- Local section symbol declaration
<b>SECTION</b>	- Start section
<b>SET</b>	- Set symbol to a value
<b>XDEF</b>	- External section symbol definition
<b>XREF</b>	- External section symbol reference

### 6.3.3.4 Data Definition/Storage Allocation

The directives used to control constant data definition and storage allocation are:

<b>BADDR</b>	- Set buffer address
<b>BSB</b>	- Block storage bit-reverse
<b>BSC</b>	- Block storage of constant
<b>BSM</b>	- Block storage modulo
<b>BUFFER</b>	- Start buffer
<b>DC</b>	- Define constant
<b>DCB</b>	- Define constant byte
<b>DS</b>	- Define storage
<b>DSM</b>	- Define modulo storage
<b>DSR</b>	- Define reverse carry storage
<b>ENDBUF</b>	- End buffer

Assembling the Program

**6.3.3.5 Listing Control and Options**

The directives used to control the output listing are:

<b>LIST</b>	- List the assembly
<b>LSTCOL</b>	- Set listing field widths
<b>NOLIST</b>	- Stop assembly listing
<b>OPT</b>	- Assembler options
<b>PAGE</b>	- Top of page/size page
<b>PRCTL</b>	- Send control string to printer
<b>STITLE</b>	- Initialize program subtitle
<b>TABS</b>	- Set listing tab stops
<b>TITLE</b>	- Initialize program title

**6.3.3.6 Object File Control**

The directives used for control of the object file are:

<b>COBJ</b>	- Comment object code
<b>IDENT</b>	- Object code identification record
<b>SYMOBJ</b>	- Write symbol information to object file

### 6.3.3.7      **Macros and Conditional Assembly**

The directives used for macros and conditional assembly are:

<b>DUP</b>	- Duplicate sequence of source lines
<b>DUPA</b>	- Duplicate sequence with arguments
<b>DUPC</b>	- Duplicate sequence with characters
<b>DUPF</b>	- Duplicate sequence in loop
<b>ENDIF</b>	- End of conditional assembly
<b>ENDM</b>	- End of macro definition
<b>EXITM</b>	- Exit macro
<b>IF</b>	- Conditional assembly directive
<b>MACLIB</b>	- Macro library
<b>MACRO</b>	- Macro definition
<b>PMACRO</b>	- Purge macro definition

### 6.3.3.8      **Structured Programming**

The directives used for structured programming are:

<b>.BREAK</b>	- Exit from structured loop construct
<b>.CONTINUE</b>	- Continue next iteration of structured loop
<b>.ELSE</b>	- Perform following statements when .IF false
<b>.ENDF</b>	- End of .FOR loop
<b>.ENDI</b>	- End of .IF condition
<b>.ENDL</b>	- End of hardware loop
<b>.ENDW</b>	- End of .WHILE loop
<b>.FOR</b>	- Begin .FOR loop
<b>.IF</b>	- Begin .IF condition
<b>.LOOP</b>	- Begin hardware loop
<b>.REPEAT</b>	- Begin .REPEAT loop
<b>.UNTIL</b>	- End of .REPEAT loop
<b>.WHILE</b>	- Begin .WHILE loop

### 6.3.4 Assembling the Example Program

The Assembler is a MS-DOS based program, thus to use the Assembler you will need to exit Windows or open a MS-DOS Prompt Window. To assemble the example program, type ***asm56000 -a -b -l -g example.asm*** in the evm007 directory created by the installation process from **Section 1.4.3**. This will create two additional files: example.cld and example.lst. The example.cld file is the absolute object file of the program, and this is what will be downloaded into the DSP56009. The example.lst file is the listing file and gives full details of where the program and data will be placed in the DSP56009 memory.

## 6.4 MOTOROLA DSP LINKER

Though not needed for our simple example, the Motorola DSP Linker is also discussed here in the DSP56009EVM User's Manual. The DSP Linker may be obtained through your Motorola sales office or distributor. The Motorola DSP Linker is a program that processes relocatable object files produced by the Motorola DSP Assembler, generating an absolute executable file that can be downloaded to the DSP56009. The general format of the command line to invoke the Linker is:

***dsplnk [options] <filenames>***

where ***dsplnk*** is the name of the Motorola DSP Linker program, and ***<filenames>*** is a list of the relocatable object files to be linked. The following section describes the Linker options. To avoid ambiguity, the option arguments should immediately follow the option letter with no blanks between them.



### 6.4.1 Linker Options

#### **-A**

This option auto-aligns circular buffers. Any modulo or reverse-carry buffers defined in the object file input sections are relocated independently in order to optimize placement in memory. Code and data surrounding the buffer are packed to fill the space formerly occupied by the buffer and any corresponding alignment gaps.

Example: ***dsplnk -A myprog.cln***

This example links the file `myprog.cln` and optimally aligns any buffers encountered in the input.

#### **-B<objfil>**

This option specifies that an object file is to be created for Linker output. <objfil> can be any legal operating system filename, including an optional pathname. If no filename is specified, or if the **-B** option is not present, the Linker will use the basename (filename without extension) of the first filename encountered in the input file list and append `.cld` to the basename. If the **-I** option is present (see below), an explicit filename must be given. This is because if the Linker followed the default action, it possibly could overwrite one of the existing input files. The **-B** option should be specified only once. If the file named in the **-B** option already exists, it will be overwritten.

Example: ***dsplnk -Bfilter.cld main.cln fft.cln fio.cln***

In this example, the files `main.cln`, `fft.cln`, and `fio.cln` are linked together to produce the absolute executable file `filter.cld`.

#### **-EA<errfil> or -EW<errfil>**

These options allow the standard error output file to be reassigned on hosts that do not support error output redirection from the command line. <errfil> must be present as an argument, but can be any legal operating system filename, including an optional pathname. The **-EA** option causes the standard error stream to be written to <errfil>; if <errfil> exists, the output stream is appended to the end of the file. The **-EW** option also writes the standard error stream to <errfil>; if <errfil> exists it will be overwritten.

Example: ***dsplnk -EWerrors myprog.cln***

### Motorola DSP Linker

This example redirects the standard error output to the file errors. If the file already exists, it will be overwritten.

#### **-F<argfil>**

This option indicates that the Linker should read command line input from <argfil>. <argfil> can be any legal operating system filename, including an optional pathname. <argfil> is a text file containing further options, arguments, and filenames to be passed to the Linker. The arguments in the file need be separated only by some form of white space. A semicolon on a line following white space makes the rest of the line a comment.

Example: ***dsplnk -Fopts.cmd***

This example invokes the Linker and takes command line options and input filenames from the command file opts.cmd.

#### **-G**

This option sends source file line number information to the object file. The generated line number information can be used by debuggers to provide source-level debugging.

Example: ***dsplnk -B -Gmyprog.cln***

This example links the file myprog.cln and sends source file line number information to the resulting object file myprog.cld.

#### **-I**

The Linker ordinarily produces an absolute executable file as output. When the **-I** option is given, the Linker combines the input files into a single relocatable object file suitable for reprocessing by the Linker. No absolute addresses are assigned and no errors are issued for unresolved external references. Note that the **-B** option must be used when performing incremental linking in order to give an explicit name to the output file. If the filename were allowed to default, it could overwrite an existing input file.

Example: ***dsplnk -I -Bfilter.cln main.cln fft.cln fio.cln***

In this example, the files main.cln, fft.cln, and fio.cln are combined to produce the relocatable object file filter.cln.

**-L<library>**

The Linker ordinarily processes a list of input files, which each contain a single relocatable code module. If the **-L** option is encountered, the Linker treats the following argument as a library file and searches the file for any outstanding unresolved references. If a module is found in the library that resolves an outstanding external reference, the module is read from the library and included in the object file output. The Linker continues to search a library until all external references are resolved or no more references can be satisfied within the current library. The Linker searches a library only once, when it is encountered on the command line. Therefore, the position of the **-L** option on the command line is significant.

Example: ***dsplnk -B filter main fir -Lio***

This example illustrates linking with a library. The files *main.cln* and *fir.cln* are combined with any needed modules in the library *io.lib* to create the file *filter.cld*.

**-M<mapfil>**

This option indicates that a map file is to be created. <mapfil> can be any legal operating system filename, including an optional pathname. If no filename is specified, the Linker will use the basename (filename without extension) of the first filename encountered in the input file list and append *.map* to the basename. If the **-M** option is not specified, then the Linker will not generate a map file. The **-M** option should be specified only once. If the file named in the **-M** option already exists, it will be overwritten.

Example: ***dsplnk -M filter.cln gauss.cln***

In this example, the files *filter.cln* and *gauss.cln* are linked together to produce a map file. Because no filename was given with the **-M** option, the output file will be named using the basename of the first input file, in this case *filter*. The map file will be called *filter.map*.

**-N**

The Linker considers case significant in symbol names. When the **-N** option is given the Linker ignores case in symbol names; all symbols are mapped to lower case.

Example: ***dsplnk -N filter.cln fft.cln fio.cln***

### Motorola DSP Linker

In this example, the files `filter.cln`, `fft.cln`, and `fio.cln` are linked to produce the absolute executable file `filetr.cld`. All symbol references are mapped to lower case.

#### **-O<mem>[<ctr>][<map>]:<origin>**

By default, the Linker generates instructions and data for the output file beginning at absolute location zero for all DSP memory spaces. This option allows the programmer to redefine the start address for any memory space and associated location counter. <mem> is one of the single-character memory space identifiers (X, Y, L, P). The letter may be upper or lower case. The optional <ctr> is a letter indicating the High (H) or Low (L) location counters. If no counter is specified, the default counter is used. <map> is also optional and signifies the desired physical mapping for all relocatable code in the given memory space. It may be I for Internal memory, E for External memory, R for ROM, A for Port A, and B for Port B. If <map> is not supplied, then no explicit mapping is presumed. The <origin> is a hexadecimal number signifying the new relocation address for the given memory space. The **-O** option may be specified as many times as needed on the command line. This option has no effect if incremental linking is being done (see the **-I** option).

Example: ***dsplnk -Ope:200 myprog -Lmylib***

This example initializes the default P memory counter to hex 200 and maps the program space to external memory.

#### **-P<pathname>**

When the Linker encounters input files, the current directory (or the directory given in the library specification) is first searched for the file. If it is not found and the **-P** option is specified, the Linker prefixes the filename (and optional pathname) of the file specification with <pathname> and searches the newly formed directory pathname for the file. The pathname must be a legal operating system pathname. The **-P** option may be repeated as many times as desired.

Example: ***dsplnk -P\project\ testprog***

This example uses IBM PC pathname conventions, and would cause the Linker to prefix any library files not found in the current directory with the `\project\` pathname.

#### **-R<ctlfil>**

This option indicates that a memory control file is to be read to determine the placement of sections in DSP memory and other Linker control functions. <ctlfil> can

be any legal operating system filename, including an optional pathname. If a pathname is not specified, an attempt will be made to open the file in the current directory. If no filename is specified, the Linker will use the basename (filename without extension) of the first filename encountered in the link input file list and append .ctl to the basename. If the **-R** option is not specified, then the Linker will not use a memory control file. The **-R** option should be specified only once.

Example: ***dsplnk -Rproj filter.cln gauss.cln***

In this example, the files filter.cln and gauss.cln are linked together using the memory file proj.ctl.

**-U<symbol>**

This option allows the declaration of an unresolved reference from the command line. <symbol> must be specified. This option is useful for creating an undefined external reference in order to force linking entirely from a library.

Example: ***dsplnk -Ustart -Lproj.lib***

This example declares the symbol start undefined so that it will be resolved by code within the library proj.lib.

**-V**

This option causes the Linker to report linking progress (beginning of passes, opening and closing of input files) to the standard error output stream. This is useful to insure that link editing is proceeding normally.

Example: ***dsplnk -V myprog.cln***

This example links the file myprog.cln and sends progress lines to the standard error output.

#### **-X<opt>[,<opt>,...,<opt>]**

The **-X** option provides for link time options that alter the standard operation of the Linker. The options are described below (\* means default). All options may be preceded by **NO** to reverse their meaning. The **-X<opt>** sequence can be repeated for as many options as desired.

<u>Option</u>	<u>Meaning</u>
ABC*	Perform address bounds checking
AEC*	Check form of address expressions
ASC	Enable absolute section bounds checking
CSL	Cumulate section length data
ESO	Do not allocate memory below ordered sections
OVLP	Warn on section overlap
RO	Allow region overlap
RSC*	Enable relative section bounds checking
SVO	Preserve object file on errors
WEX	Add warning count to exit status

Example: ***dsplnk -XWEX filter.cln fft.cln fio.cln***

This example allows the Linker to add the warning count to the exit status so that a project build will abort on warnings as well as errors.

#### **-Z**

This option allows the Linker to strip source file line number and symbol information from the output file. Symbol information normally is retained for debugging purposes. This option has no effect if incremental linking is being done (see the **-I** option).

Example: ***dsplnk -Zfilter.cln fft.cln fio.cln***

In this example, the files *filter.cln*, *fft.cln*, and *fio.cln* are linked to produce the absolute object file *filter.cln*. The output file will contain no symbol or line number information.

## 6.4.2 Linker Directives

Similar to the Assembler directives, the Linker includes mnemonic directives that specify auxiliary actions to be performed by the Linker. The following sections briefly describe the Linker directives.

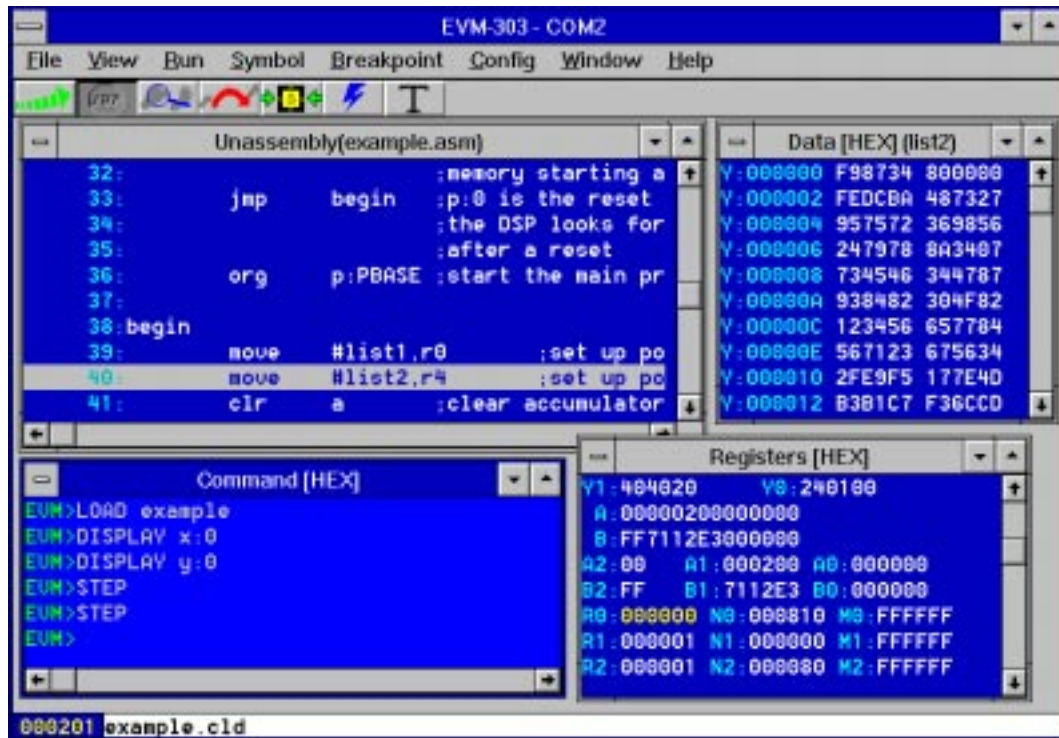
<b>BALIGN</b>	- Auto-align circular buffers
<b>BASE</b>	- Set region base address
<b>IDENT</b>	- Object module identification
<b>INCLUDE</b>	- Include directive file
<b>MAP</b>	- Map file format control
<b>MEMORY</b>	- Set region high memory address
<b>REGION</b>	- Establish memory region
<b>RESERVE</b>	- Reserve memory block
<b>SBALIGN</b>	- Auto-align section buffers
<b>SECSIZE</b>	- Pad section length
<b>SECTION</b>	- Set section base address
<b>SET</b>	- Set symbol value
<b>SIZSYM</b>	- Set size symbol
<b>START</b>	- Establish start address
<b>SYMBOL</b>	- Set symbol value

## 6.5 INTRODUCTION TO THE DEBUGGER SOFTWARE

This section will give a brief introduction of the Domain Technologies Debugger, detailing only that which is required to work through this example. Full details of the Debugger and an informative tutorial can be found in the Debug-56K Manual. The Domain Technologies Debugger is a software development system for the DSP56009. The Domain Technologies Debugger is included with the DSP56009EVM on the Domain Technologies 3-1/2 inch diskette and can be installed by following the instructions in **Section 1.4.3**. To invoke the Debugger, double-click on the icon labelled EVM56007 Debugger in the EVM56007 program group that was created when the Debugger was installed.

The Debugger display will be similar to **Figure 6-2**, with the screen divided into four windows: the command window, the data window, the unassembled window, and the registers window (DSP56303EVM Debugger shown). The command window is the window selected, which means that key strokes will be placed in the command window. The command window is where commands are entered. The data window is used to display DSP56009 data. The unassembled window is used to display the DSP56009 programs. The next instruction to be executed will be highlighted. The registers window shows the contents of the DSP56009 internal registers.





**Figure 6-2** Example Debugger Window Display

When the command window is selected as in **Figure 6-2**, the tool-bar at the top of the screen contains buttons for the most often used commands. From right to left the commands are: go, stop, step, jump, automatic update, reset and radix. The go button runs the DSP56009 from the program counter. The stop button stops the DSP56009. The step button executes a single instruction. The jump button is similar to the step button, except that subroutines are treated as one instruction. The automatic update button turns the automatic screen update mode on, so that the DSP56009 is interrupted periodically to update the data and registers windows. The reset button resets the DSP56009. The radix button can be used to change the radix of the selected window. Other buttons will appear when other windows are selected, and the function of these buttons can be found in the Debug-56K Manual.

## 6.6 RUNNING THE PROGRAM

To load the example program developed above into the Debugger, click in the command window and type **load example**. The instruction at line 33 will be highlighted in the unassembled window, as this will be the first instruction to be executed. However, before we start to execute the program, we should check that the values we expect to be in data memory are there. To do this, type **display x:0** and **display y:0**. The data will be displayed in the data window.

To step through the program, type **step** at the command window prompt. As a shortcut, you can click on the step button or you can type the start of the command and press the space bar, and the debugger will complete the remainder of the command. To repeat the last command, simply press return. As you step through the code, you will see the registers in the registers window being changed by the instructions. After each cycle, any register that has been changed will be brightened. Once you have stepped through the program, ensure that the program has executed correctly by checking that the result in accumulator a is: \$FE 9F2051 6DFCC2.

Stepping through the program like this is good for short programs, but it is impractical for large complex programs. The way to debug large programs is to set breakpoints. These are user-defined points at which execution of the code will stop, allowing the user to step through the section of interest. To set a breakpoint in the example to check that the values in r0 and r4 are correct before the do loop, type **break p:\$106** in the command window. You will see the line before the loop brighten in the unassembled window, indicating the breakpoint has been set. To point the DSP56009 back to the start point of the program, type **change pc 0**. This changes the program counter such that it is pointing to the reset vector. To start the program running type **go** or click on the go button. The DSP56009 will stop when it reaches the breakpoint, and you will be able to step through the remainder of the code.

To exit the Debugger, type **quit** at the command prompt.



# **APPENDIX A**

## **AUDIO PASS-THROUGH EXAMPLE**

A.1	PASS-THROUGH THEORY . . . . .	A-93
A.2	SPDIF INPUT PASS-THROUGH THEORY . . . . .	A-94
A.3	EVM SETUP FOR AUDIO PASS-THROUGH. . . . .	A-95

## A.1 PASS-THROUGH THEORY

The main program loop of the `passthru.asm` code serves as a reference guide on how to pass data into and out of the EVM.

The following describes the operation of the `passthru.asm` program.

Audio samples are composed of left and right data words that are received and transmitted alternately. The `RX_HERE` bit is polled until it is set, indicating that a the left data word is shifted in on the associated serial receive data pin (`SDI0` or `SDI1`) and transferred to the receive data register (`RX0`, `RX1`, or `RX2`). This bit is cleared after the word is received.

The left receive interrupt service routine moves the word in the receive data register into the receive buffer `LEFT_AUDIN`. The received word is also saved into another register such as `X1`. The user's code may be inserted in this section to perform any necessary audio processing.

The word to be transmitted out, stored in `X1` is then moved into the `LEFT_AUDOUT` transmit buffer. The left transmit interrupt service routine moves the word in the transmit buffer into the transmit data register (`TX0`, `TX1`, or `TX2`) and it is shifted out on the associated serial transmit data pin (`SDO0`, `SDO1`, or `SDO2`).

The right data is received and transmitted similarly. After the right word is received, the `RX_HERE` bit is set in the right receive interrupt routine to indicate that the next data to be received (left data) is a new sample.

The program loops back to the beginning of the main code to receive the next sample.

The illustration shown in **Figure A-1** is the interrupt sequence for analog audio input.

```

SAI_LFT_TX_IRQ
    MOVEP    X:LEFT_AUDOUT,X:TX0
    MOVEP    X:LEFT_AUDOUT,X:TX1
    MOVEP    X:LEFT_AUDOUT,X:TX2
    ;movep    x:left_digout,x:tx0
    ;movep    x:left_digout,x:tx1
    ;movep    x:left_digout,x:tx2
    RTI
;
SAI_RGT_TX_IRQ
    MOVEP    X:RIGHT_AUDOUT,X:TX0
    MOVEP    X:RIGHT_AUDOUT,X:TX1
    MOVEP    X:RIGHT_AUDOUT,X:TX2
    ;movep    x:right_digout,x:tx0
    ;movep    x:right_digout,x:tx1
    ;movep    x:right_digout,x:tx2
    RTI

```

**Figure A-1** Output Interrupt Structure for Analog Input

## A.2 SPDIF INPUT PASS-THROUGH THEORY

In order to perform the pass-through example with the S/PDIF input instead of the analog inputs, a few changes must be made to the file, `passthru.asm`. The structure already supports digital input buffers, therefore the only change necessary to enable digital audio input is in the interrupt routines, as shown below in **Figure A-2**.

```

SAI_LFT_TX_IRQ
    ;MOVEP    X:LEFT_AUDOUT,X:TX0
    ;MOVEP    X:LEFT_AUDOUT,X:TX1
    ;MOVEP    X:LEFT_AUDOUT,X:TX2
    movep     x:left_digout,x:tx0
    movep     x:left_digout,x:tx1
    movep     x:left_digout,x:tx2
    RTI
;
SAI_RGT_TX_IRQ
    ;MOVEP    X:RIGHT_AUDOUT,X:TX0
    ;MOVEP    X:RIGHT_AUDOUT,X:TX1
    ;MOVEP    X:RIGHT_AUDOUT,X:TX2
    movep     x:right_digout,x:tx0
    movep     x:right_digout,x:tx1
    movep     x:right_digout,x:tx2
    RTI

```

**Figure A-2** Output Interrupt Structure for Digital Input

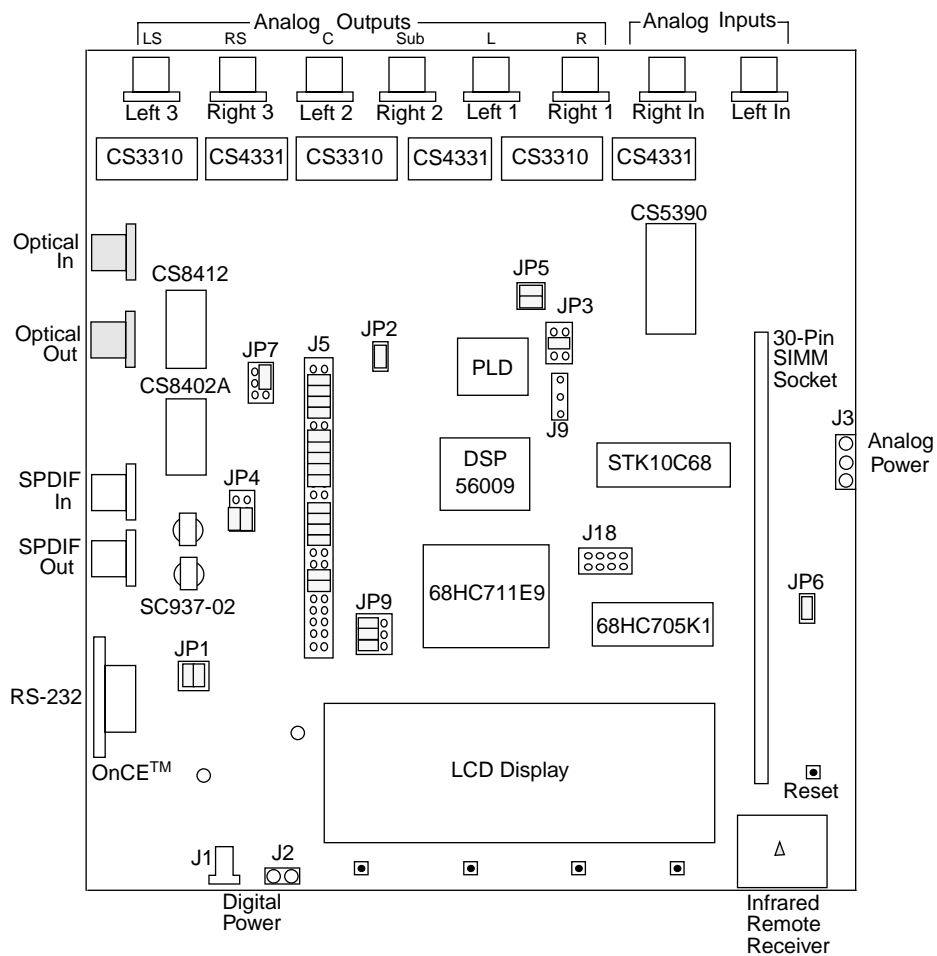
### A.3 EVM SETUP FOR AUDIO PASS-THROUGH

The input sources for the respective output channels for the demo, `passthru.cld`, are illustrated below in **Table A-1**. The output channels are specified in the output interrupt routines, `SAI_LFT_TX_IRQ` and `SAI_RGT_TX_IRQ`.

**Table A-1** Output sources for audio pass-through

Audio Source	EVM output
Analog Inputs	Left 1 Right 1
Analog Inputs	Left 2 Right 2
Digital Inputs	Left 3 Right 3

The audio pass-through EVM jumper configuration is illustrated below in **Figure A-3**. Note that JP5 is configured to clock from the DSP clock and receive analog input data. Therefore, in order to receive the SPDIF input clock and data the jumper on JP5.3 and JP5.4 must be removed. Also, note that JP4 is set for non-Optical input.



**Figure A-3** DSP56009EVM Pass-through Setup





# **APPENDIX B**

## **SOUND FIELD PROCESSING EXAMPLE**

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## B.1 INTRODUCTION

The phrase “sound field processing” seems to embody a sense of extra space added to an original sound. With the advent of practical multichannel sound, processing certain sound fields artificially became attainable and edifies the listening environment when certain theaters or other settings are replicated in software. In order to create the delay and reverberation elements that typify certain acoustical spaces, filtering and delay components must be instituted. Therefore, DSPs ideally might handle even the toughest simulation.

The soundfield processing example offered here is a design based around studies performed independently by Manfred Schroeder and James Moorer<sup>1</sup>. Each provide important insight into effective algorithms that create artificial reverberation. This appendix will explain specifically the reverberation blocks inherent in one particular example; however, this example provides only one of many as defined by Schroeder and Moorer. This implementation uses filter coefficients collected by Schroeder that imitate the Boston Concert Hall. A four channel output is generated: left front, right front, left rear, and right rear; with a summed output feeding the center channel which may also be lowpass filtered to be used for a subwoofer channel. The complete block diagram of the system is shown in **Figure B-8**.

The software to implement this design is provided on the DSP56009 diskette for viewing/editing as `SFPEVM09.ASM` and for downloading onto the EVM as `SFPEVM09.CLD`. The `SFPEVM09.ASM` may be operated with either a DSP56004, DSP56007, or DSP56009.

The basic reverberation elements utilized in the file, `SFPEVM09.ASM`, include an early reflection FIR filter for each of the four main channels and a reverberation unit comprised of six parallel comb filters and a single all-pass filter.

This code as written can be implemented on the DSP56009EVM.

## B.2 EARLY REFLECTIONS

Schroeder suggested a method for simulating early wall reflections and room geometry by combining the direct summation of the original signal with a standard unit reverberator to recreate late echos. The theory proposes that the first gains and delays simulate the room’s geometry patterned after an FIR (non-recursive) filter structure; and the unit reverberator/IIR (recursive) filter imitates the decay of the reverberation once the pulses become inseparable.

1. Moore, James. “About this Reverberation Business.” *Computer Music Journal*, Vol 3, #2.

## Early Reflections

Implemented in software, the algorithm takes advantage of the SAI (Serial Audio Interface) and the EMI (External Memory Interface), two of the peripherals on Motorola's Symphony™ line of DSPs. The input samples are received by the SAI as left and right channel data stored in memory. These samples are delayed several milliseconds and retrieved according to the early reflection offset table ER\_off\_buf. ER\_off\_buf is constructed as a seven-tap FIR section (See **Figure B-1**). **Table B-1** below illustrates the respective tap and its associated time delay and gain as patterned after the Boston Concert Hall.

**Table B-1** Early Reflection FIR Structure

Tap	Time Delay	Gain
0	0	1.00
1	0.0199	1.02
2	0.0354	0.818
3	0.0389	0.635
4	0.0414	0.719
5	0.0699	0.267
6	0.0796	0.242

Twelve samples are read from the delay line (two channels, left and right, multiplied by the offset table which is six deep) and four FIR filters are calculated. Reading of the delayed samples is triggered by writing offset values to the EMI's EOR0 and EOR1 registers (as defined by the values in ER\_DAx). The FIR filter creates the early reflection defining the room size and reflective characteristics of the room environment.

The FIR filter is implemented within a DO loop (instructions 33-70) in which the offset information is retrieved by a post incrementing pointer, r4, and the left and right data samples are read via the EDR registers. The DO loop is shown in **Figure B-1** below.

```

1          clr      a      #ER_off_buf,r4          ;clr acc, offset start
2                                          ;address in r4.
3 !loop reduce
4          clr      b      #ER_gains, r1           ;clr acc, gains start
5                                          ;address in r1.
6 !loop reduce
7          move     m7,m1                          ;set linear
8          move     #front,r5                      ;pointer r5 for samples
9          movep    x:(ER_ebar),x:EBAR0            ;FIR left delay line
10         movep    y:(ER_ebar),x:EBAR1            ;FIR right delay line
11         move     l:(r4)+,x                      ;get 1'st stage left and
12                                          ;right offsets

```

```

13      movep      x1,x:EOR0                ;1st stage trigger of left
14      movep      x0,x:EOR1                ;1st stage trigger of right
                                           .
                                           .
                                           .
33      do          #(nFIR-1),end_FIR ; EMI reading
34
35      move          l:(r4)+,x ; get next stage l & r offsets
36
37      movep      x1,x:EOR0                ; next left trigger
38      movep      x:EDR0,x1                ; get left sample
39      movep      x0,x:EOR1                ; next right trigger
40      movep      x:EDR1,y1                ; get right sample
41 ; front
42
43      mac    x1,y0,a x:(r1)+,x0  b,y:(r5)- ;left from left,
44                                           ;get left front right gain,
45                                           ; store right rear
46      macr   x0,y1,a x:(r1),x0  y:(r5),b   ; left from right,
47                                           ; get right front
48                                           ; right gain,
49                                           ; get right front
50      mac    x0,y1,b a,x:(r5)+  y:(r1)+,y0 ;right from right,
51                                           ;get right front left gain,
52                                           ; store left front
53      macr   x1,y0,b x:(r5)-,a   y:(r1),y0 ;right from left,
54                                           ;get left rear left gain,
55                                           ; get left rear
56 ; rear
57
58      mac    x1,y0,a x:(r1)+,x0  b,y:(r5)+ ;left from left,
59                                           ;get left rear right gain,
60                                           ; store right front
61      macr   x0,y1,a x:(r1),x0  y:(r5),b   ;left from right,
62                                           ;get right rear right gain,
63                                           ; get right rear
64      mac    x0,y1,b a,x:(r5)-  y:(r1)+,y0 ;right from right,
65                                           ;get right rear left gain,
66                                           ; store left rear
67      macr   x1,y0,b x:(r5)+,a   y:(r1),y0 ;right from left,
68                                           ;get left front left gain,
69                                           ; get left front
70 end_FIR
71 ; complete the loop
72      move      l:(in_in),x          ; get l & r delay line samples
73
74      movep     x1,x:EDR0              ; store l_in (base incremented)
75      movep     x:EDR0,x1              ; get last left sample
76      movep     x0,x:EDR1              ; store r_in (base incremented)
77      movep     x:EDR1,y1              ; get last r sample

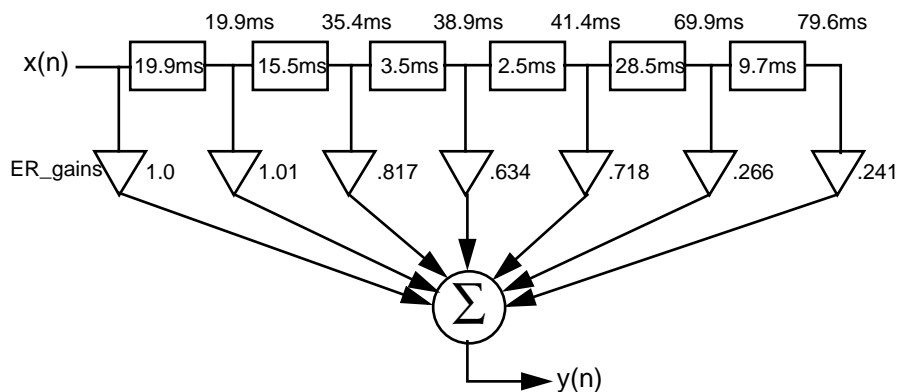
```

Figure B-1 Early Reflection DO loop

The early reflection part is constructed such that the first EMI write transfer triggers are performed in lines 13-14 before the DO loop; therefore, the first delayed EMI read can occur after the first offsets are retrieved from X and Y memory in line 35 within the DO loop. Following the beginning of the DO loop, a trigger occurs (lines 37 and 39). In the next iteration of the DO loop the corresponding read occurs (lines 38 and 40). Therefore, the final EMI reads transpire at the termination of the loop in lines 75 and 77 and the final left and right delay line samples are stored in X memory (line 72).

Each time the loop executes, the left and right samples are multiplied by their corresponding gains from ER\_gains in pointer r1 (lines 43, 46) and routed to the corresponding output. For instance, the comment in line 43, “; left from left” signifies that the left FIR multiply is routed to the left output. The comment in line 46, “; left from right” likewise denotes that the right FIR multiply is routed to the left output. This structure can be explicitly seen in **Figure B-8** on page -110. The pointer, r5, contains the input samples for the early reflections and the pointer, r4, contains the delay values for the FIR as stated previously.

The block diagram of the early reflection is illustrated in **Figure B-2**.



**Figure B-2** Early Reflection FIR Block (one channel)

### B.3 DELAY LINE FOR COMBS/REVERBERATION

This portion of the code acts as the gathering point for the results of the four early reflection FIR blocks for the left front, right front, left rear, and right rear, respectively. The saved values from each of these processes are summed with averaging weights and stored in a delay line for use in the following comb filter and all-pass filter blocks,

which generate the diffuse reverberation. The timing of the delay is designed to synchronize the inputs to the comb filter section. The summed value is routed to the center channel.

## B.4 COMB FILTER

Following the early reflections, there follows a section of six parallel comb filters that create diffuse field reverberation. Recursive comb filters provide delay and incorporate feedback, which generate a “toothed” frequency response. Moorer determined that the gain,  $g$ , should be a function of the reverberation time according to the formula:

$$g = 1 - 0.366/T \text{ where } T = \text{reverberation time} \quad (\text{G.1})$$

The values of the optimal gain in the feedback loop,  $g_1$ , are determined by the room humidity versus distance from the source and the sample rate of the system. From Moorer’s diagrams, the coefficients for a 44.1 kHz sample rate can be discerned. Larger values of  $g_1$  will produce bright reverberation at the onset followed by a muffled decay. The loopback gain,  $g_2$ , can be determined by the equation

$$g_2 = g(1 - g_1) \quad (\text{G.2})$$

The total reverberation time for SFPEVM09.ASM is designed for two seconds. Therefore, using (G.1), the overall gain,  $g$ , is 0.83. The values of  $g_1$  for the seven-tap comb filter model are shown in **Table B-2** below.

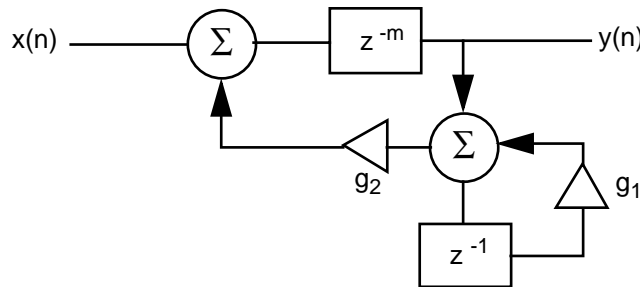
**Table B-2** Comb filter loop-back gains

Comb #	Delay (in ms)	$g_1$
Comb 1	50	0.45
Comb 2	56	0.47
Comb 3	61	0.49
Comb 4	68	0.51
Comb 5	72	0.52
Comb 6	78	0.54

The block diagram of one of the six comb filter structures is shown in **Figure B-3**

## All-Pass Filter

below.



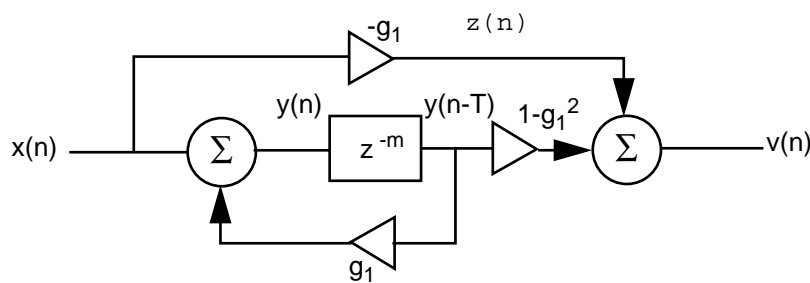
**Figure B-3** Comb Filter (one of six)

The output of each of the six comb filters is summed and routed to the all-pass filter portion of the program.

## B.5 ALL-PASS FILTER

The all-pass filter has a flat frequency response from 0 Hz to the Nyquist frequency; however, the phase response delays different frequencies by different amounts. This provides a very distinct sound approaching a phasing effect. Moorer defines the most natural sounding unit reverberator to contain a number of comb filters and a single all-pass filter. He also states that the use of more than six parallel comb filters and one all-pass filter does not significantly enhance reverberant qualities. Therefore, only a single all-pass filter is implemented here. The delay must be set to six milliseconds or less, as longer delays produce what Moorer describes as an audible repetition. The gain, constant  $g$ , of the all-pass filter is 0.7.

The block diagram for the all-pass filter is shown in **Figure B-4**.



**Figure B-4** All-pass Filter



The value  $z(n)$ , which is the value of the upper gain stage, is computed first, the delay  $z^{-m}$  is accessed from the EDR0 (EMI Data Read register), and  $v(n)$  is computed. The parallel move feature of Motorola's DSP56K architecture allows this arithmetic to be achieved in only four instructions, as shown in **Figure B-5**.

```

1      move    b,y0      x:(r6)+,x1    ; transfer x(n) to y0 for
2                                      ; multiplication get 1-k**2 at x1
3      mpy     -y0,y1,a   x:(r0),x0    ; z(n)=-k*x(n),
4                                      ; get y(n-T) from EDR0 to x0
5      macr    x0,y1,b    (r4)-        ; compute y(n)= x(n)+k*y(n-T)
6                                      ; pointer goes to APF end
7      macr    x0,x1,a    b,x:(r0)     ; compute v(n)=z(n)+(1-k**2)
6                                      ; *y(n-T),
8                                      ; store y(n)

```

**Figure B-5** All-Pass Filter Routine

In the above example, r6, points to the COMB\_gains, r0 points to the EMI data read register EDR0, and r4 points to EEcomb, which is the base addresses of the delays. The final instructions in the routine store the all-pass output  $v(n)$  and the base address (EBAR0) of the latest sample to be passed to the decorrelator and rear delay lines, as shown in **Figure B-6** below. A description of the de-correlator and delay line are provided in **B.6 De-Correlation Routine** on page B-105.

The all-pass portion may be set to loop to allow for more multiple filter designs. However, James Moorer states that this produces only a negligible increase in reverberant quality.

## B.6 DE-CORRELATION ROUTINE

The data stream output from the main reverb routine is combined with each of the separate early reflection values to provide the four discrete outputs: left front, right front, left rear, and right rear. This routine takes the output of the first early reflection value and decorrelates the signals from each of the other three channels. The de-correlation is performed by using all-pass filters with different coefficients to adjust the phase of each channel independently.

The all-pass filter's delay base and offset values and the gains are saved using pointers r0 and r4 and then extracted as their manipulation occurs. The instructions:

## De-Correlation Routine

save the front right and left base and offset values from the tables, EEapf\_fr and EEapf\_fr and apf\_fr\_coeffs, respectively. Then the all-pass function is simply implemented as in **B.5 All-Pass Filter** on page B-104, utilizing the corresponding channel's delays (affecting phase only in an all-pass filter).

**MOTOROLA**

The gains of the respective gains for the de-correlation all-pass filters are shown in **Table B-3** below.

**Table B-3** De-Correlation All-pass filter gains

Channel	$g_0$	$g_1 (1-g_0^2)$
LF	0.65	0.58
RF	0.80	0.36
RR	0.75	0.44
LR	0.60	0.64

## B.7 DSP56009EVM SETUP FOR SFP DEMONSTRATION

The jumper configuration necessary to run the Sound Field Processing demonstration for the DSP56009EVM is shown below in **Figure B-7**. Note that JP5 is configured to clock from the DSP clock and receive analog input data. Therefore, in order to receive the SPDIF input clock and data the jumper on JP5.3 and JP5.4 must be removed.

Sound Field Processing Example

DSP56009EVM Setup for SFP Demonstration

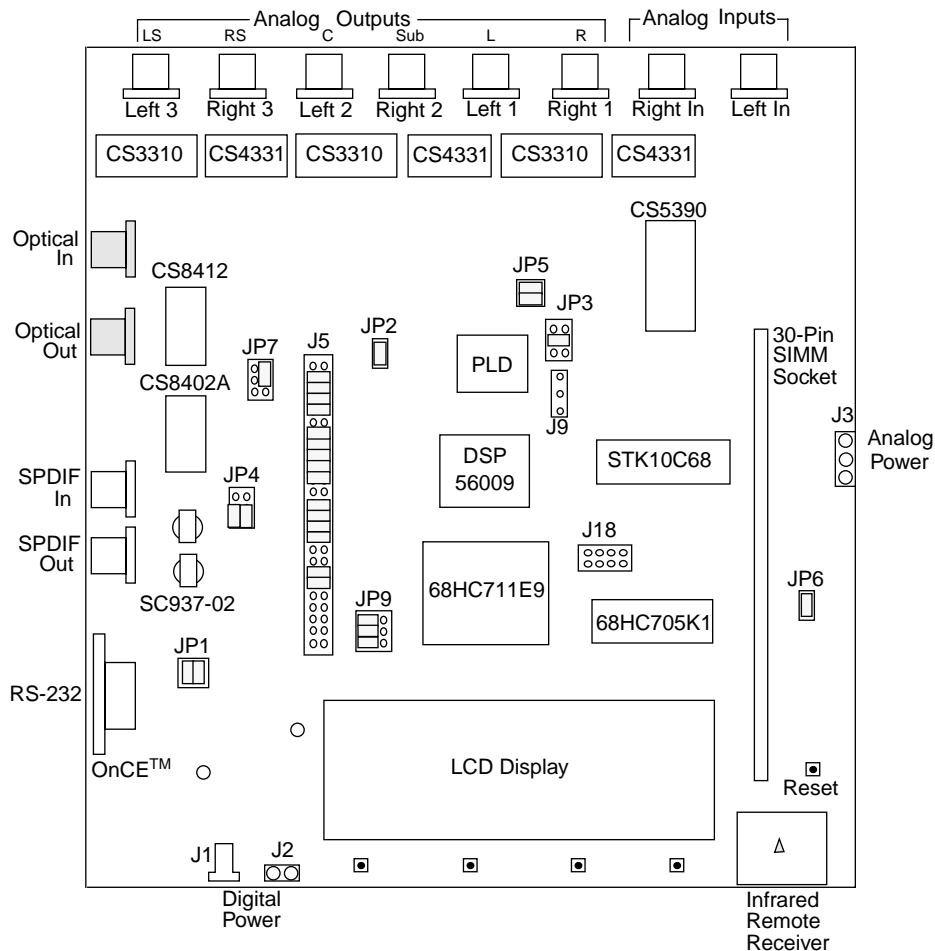


Figure B-7 EVM configuration for Sound Field Processing Demo

In order to adequately run the SFPEVM09.CLD file, a 256 kbyte 30-pin SIMM DRAM must also be provided at connector U15. An audio source, an audio amplifier driving headphones or speakers, and cables with RCA/phono connectors for five channels are required to use the demo software. The SFPEVM09.CLD demo operates with five of the six channel outputs shown in Table B-4 below.

Table B-4 Sound Field Processing Audio Outputs

EVM output	Demo channel
Left 1	Front Left
Right 1	Front Right

**Table B-4** Sound Field Processing Audio Outputs

Left 2 Right 2	N/A Center
Left 3 Right 3	Rear Left Rear Right

In order to operate the sound field processing demonstration, open the Debug-EVM and load the file, `SFPEVM09.CLD`. Once the object file has downloaded successfully, type `GO` in the command window or click on the `RUN` icon. The demonstration should now execute.

Macro commands that enable and disable the reverberation routines are provided with the Sound Field Processing code. The command file, `normal.cmd` may be input in the command window of the Domain Debugger as “normal” and the reverberation will be effectively bypassed. Likewise, the command file, `reverb.cmd` may be input in the command window as “reverb” to enable the sound field processor.

## B.8 BLOCK DIAGRAM OF THE SOUND FIELD PROCESSOR

The block diagram of the sound field processor utilizing the four aforementioned blocks is shown in **Figure B-8**.

Block Diagram of the Sound Field Processor

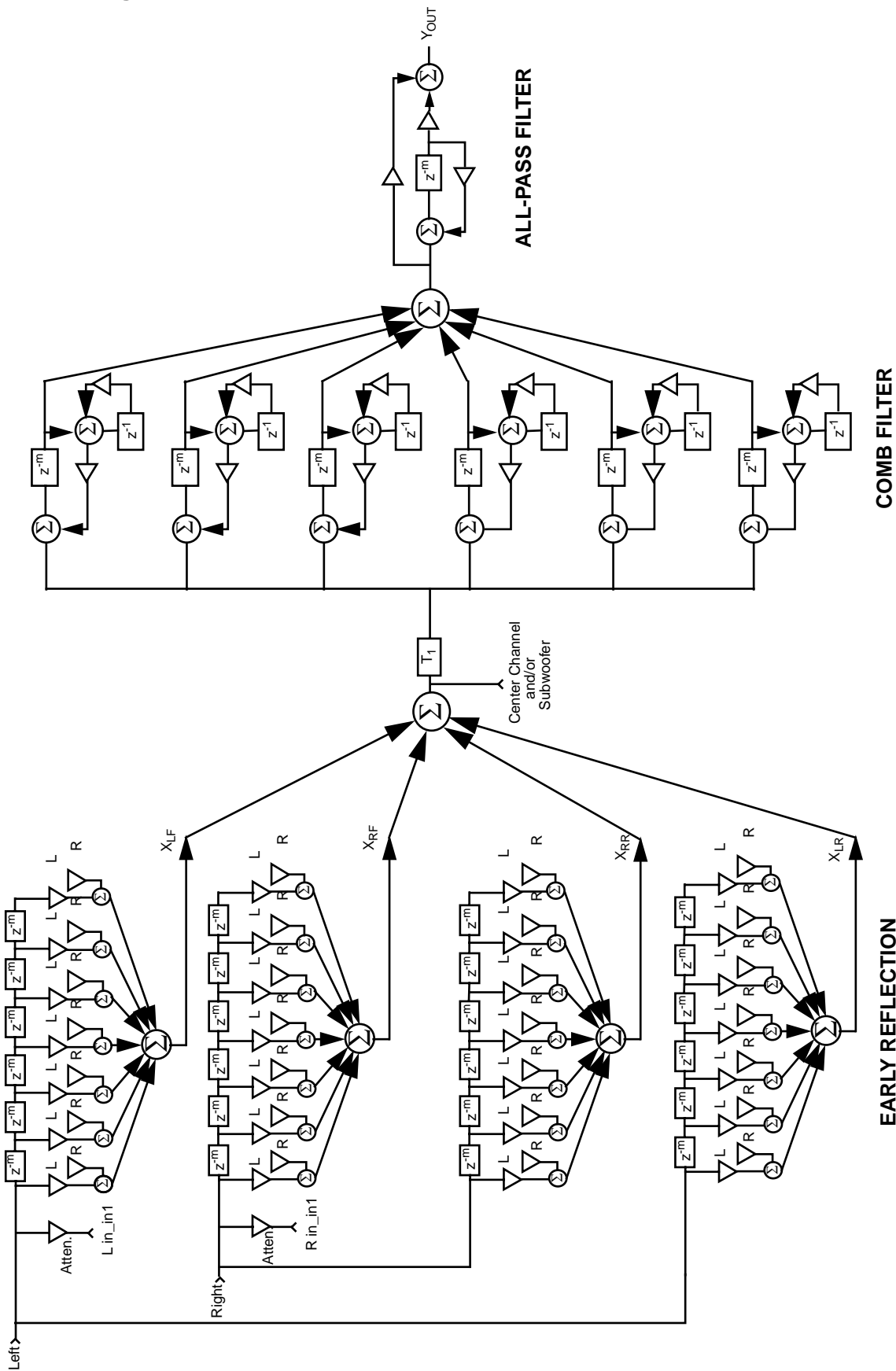


Figure B-8 Sound Field Processor

## B.9 X/Y MEMORY MAP FOR SOUND FIELD PROCESSOR

**Table B-5** shows the memory map of the X and Y memories of the DSP546009 running the SFPEVM09.CLD program.

**Table B-5** X and Y Memory Map for Sound Field Processing Demo

Label	Address	X:	Y:	Comments
RSRVD5	005b	reserved	reserved	
RSRVD4	005a	reserved	reserved	
RSRVD3	0059	reserved	reserved	
RSRVD2	0058	reserved	reserved	
RSRVD1	0057	reserved	reserved	reserved (also END_TABLE1)
apf_rl_coeffs	0056	APFAgf_RL	APFAg_RL	
apf_rr_coeffs	0055	APFAgf_RR	APFAg_RR	
apf_fl_coeffs	0054	APFAgf_FL	APFAg_FL	
apf_fr_coeffs	0053	APFAgf_FR	APFAg_FR	output allpass coefficients
EEdelay_rl	0052	DLY_RL_base	DLY_RL_OFF	
EEdelay_rr	0051	DLY_RR_base	DLY_RR_OFF	rear output delay lines
EEapf_rl	0050	APF_RL_base	APF_RL_OFF	
EEapf_rr	004f	APF_RR_base	APF_RR_OFF	
EEapf_fl	004e	APF_FL_base	APF_FL_OFF	
EEapf_fr	004d	APF_FR_base	APF_FR_OFF	allpass output stage delay lines
TCOMBS_gain	004c	tCOMBA_gain	tCOMBA_gain	total combs gain
RND_gains	004b	RNDA6g	RNDA18g	round gains
APF_gains	004a	APFAgf	APFAg	allpass filter gains
	0049	COMB6g2A	COMB6g1A	
	0048	COMB5g2A	COMB5g1A	
	0047	COMB4g2A	COMB4g1A	
	0046	COMB3g2A	COMB3g1A	
	0045	COMB2g2A	COMB2g1A	
COMB_gains	0044	COMB1g2A	COMB1g1A	comb gains
	0043	ERA_RRavg	ERA_RLavg	
D_avgs	0042	ERA_FRavg	ERA_FLavg	delay line averaging gains
	0041	ERA_RRrg6	ERA_RR1g6	
	0040	ERA_RLrg6	ERA_RL1g6	
	003f	ERA_FRrg6	ERA_FR1g6	
	003e	ERA_FLrg6	ERA_FL1g6	

**Table B-5 X and Y Memory Map for Sound Field Processing Demo**

	003d	ERA_RRrg5	ERA_RR1g5	
	003c	ERA_RLrg5	ERA_RL1g5	
	003b	ERA_FRrg5	ERA_FR1g5	
	003a	ERA_FLrg5	ERA_FL1g65	
	0039	ERA_RRrg4	ERA_RR1g4	
	0038	ERA_RLrg4	ERA_RL1g4	
	0037	ERA_FRrg4	ERA_FR1g4	
	0036	ERA_FLrg4	ERA_FL1g4	
	0035	ERA_RRrg3	ERA_RR1g3	
	0034	ERA_RLrg3	ERA_RL1g3	
	0033	ERA_FRrg3	ERA_FR1g3	
	0032	ERA_FLrg3	ERA_FL1g3	
	0031	ERA_RRrg2	ERA_RR1g2	
	0030	ERA_RLrg2	ERA_RL1g2	
	002f	ERA_FRrg2	ERA_FR1g2	
	002e	ERA_FLrg2	ERA_FL1g2	
	002d	ERA_RRrg1	ERA_RR1g1	
	002c	ERA_RLrg1	ERA_RL1g1	
	002b	ERA_FRrg1	ERA_FR1g1	
	002a	ERA_FLrg1	ERA_FL1g1	
ER_gains	0029	ERA_Ling	ERA_Ring	early reflection gains
EEapf	0028	APF_base	APFA_OFF	allpass filters EBAR and EOR pair
	0027	COMB6_base	COMB6A_OFF	
	0026	COMB5_base	COMB5A_OFF	
	0025	COMB4_base	COMB4A_OFF	
	0024	COMB3_base	COMB3A_OFF	
	0023	COMB2_base	COMB2A_OFF	
EEcomb	0022	COMB1_base	COMB1A_OFF	combs EBARs and EORs
Dcomb_ebar	0021	DL_base	DLA_OFF	delay line EBAR and EOR (also Dcomb_eor)
	0020	ER_OFFA6	ER_OFFA6	
	001f	ER_OFFA5	ER_OFFA5	
	001e	ER_OFFA4	ER_OFFA4	
	001d	ER_OFFA3	ER_OFFA3	
	001c	ER_OFFA3	ER_OFFA2	
ER_off_buf	001b	ER_OFFA2	ER_OFFA1	early reflection EORs
ER_ebar	001a	Left_base	Right_base	early reflection EBARs (also TABLE1)



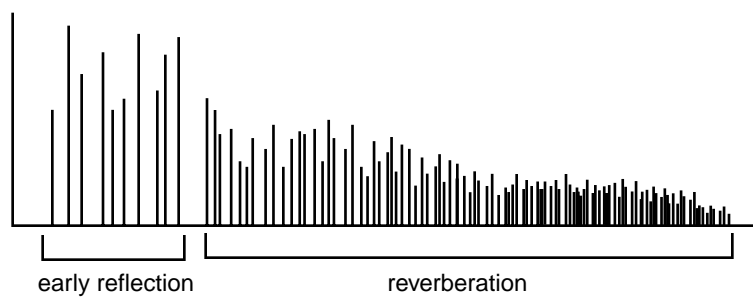
**Table B-5** X and Y Memory Map for Sound Field Processing Demo

temp2	0019	temp storage		
temp1	0018	temp storage		
t3_add	0017	x(left)	y(right)	third transmitter addresses to transmit
control	0016	control flags		
mode_timeout	0015	mode change delay count		mode change delay count
shi_mode_new	0014	shi_mode_new		
gpio_mode_new	0013	gpio_mode_new		new mode
shi_mode_set	0012	shi_mode_set	shi_counter	
gpio_mode_set	0011	gpio_mode_set	gpio_counter	mode during previous pass
apf2s	0010	reserved		2nd allpass filter in series result
apf1s	000f	apf1s		1st allpass filter in series result
APin	000e	(double precision)		input to allpass filters (also APout)
	000d		v(n-6)	
	000c		v(n-5)	
	000b		v(n-4)	
	000a		v(n-3)	
	0009		v(n-2)	
combs_states	0008		v(n-1)	internal comb state for LPF
right	0007	front	rear	right channel before output to SAI
left	0006	front	rear	left channel before output to SAI
combs_input	0005	average		input to combs
central_channel	0004	average		pre-input to combs
rear	0003	left	right	rear sample storage
front	0002	left	right	front sample storage
in_in1	0001	left_in	right_in	input samples from the SAI undisturbed by interrupts
in_in	0000	left_in	right_in	input samples from the SAI

## B.10 REVERB TIME ANALYSIS

The time analysis for the response of the sound field processor is illustrated in **Figure B-9** on the following page. The RT60 (reverberation time) is defined as two seconds.

### Reverb Time Analysis



**Figure B-9** Sound Field Processor Time Analysis



# **APPENDIX C**

## **DSP56009EVM MULTIPLEX DEFINITION**

C.1 OVERVIEW .....C-117

C.2 MULTIPLEX CABLE SPECIFICATION .....C-117

C.3 EVM SETUP FOR MULTIPLEXING .....C-118

## C.1 OVERVIEW

Two DSP56009EVMs may be connected together to utilize the memory of two Symphony DSPs. Six-channel data is multiplexed to SDI0 and SDI1, two of the SAI transmitters on the DSP of the Transmit EVM. The data is then demultiplexed on the DSP of the Receive EVM and available as discrete channels for post-processing of certain decoding algorithms on the Transmit EVM. The file `listen.cld` must be downloaded onto the Receive DSP in order to de-multiplex the serial audio stream. The user's DSP assembly files may be linked with this source file. A special cable must be built in order to take advantage of this special function.

## C.2 MULTIPLEX CABLE SPECIFICATION

The Mux cable must be connected from jumper block J5 on the Transmit board to J5 on the Receive board. The cable must be no longer than seven or eight inches (preferably six inches). There must be ground wires interspersed between each clock and data line (those marked with an \*). Ground connections can be found at pins 1, 2, 11, 12, etc. as seen in the SRAM and External Memory Interface schematic. The cable must be a ribbon cable split to carry the WST and SCKT signals and grounds physically separate from the WSR, SCKR, SDI0, and SDI1 signals and grounds.

**Table C-1** DSP56009EVM MUX Cable Pinout

Transmit	Receive	Description
*3-4	*13-14	WST
*5-6	*15-16	SCKT
*14	*4	WSR
*16	*6	SCKR
*18	*8	SDI0
*20	*10	SDI1
7-8		
9-10		
25-26		
27-28		
29-30		
31-32		
37-38		
39-40		
43-44		

**Table C-1** DSP56009EVM MUX Cable Pinout

Transmit	Receive	Description
	17-18	
	19-20	
	21-22	
	25-26	
	27-28	
	29-30	
	31-32	
	37-38	
	39-40	
	43-44	

### C.3 EVM SETUP FOR MULTIPLEXING

There are a few differences between the DSP56009EVM's typical setup and the setup for multiplexing. JP5 Jumpers must be off on both boards and the JP2 Jumper must be connected. The SPDIF connector must be input to both boards with an AC-3 demodulated bit-stream.

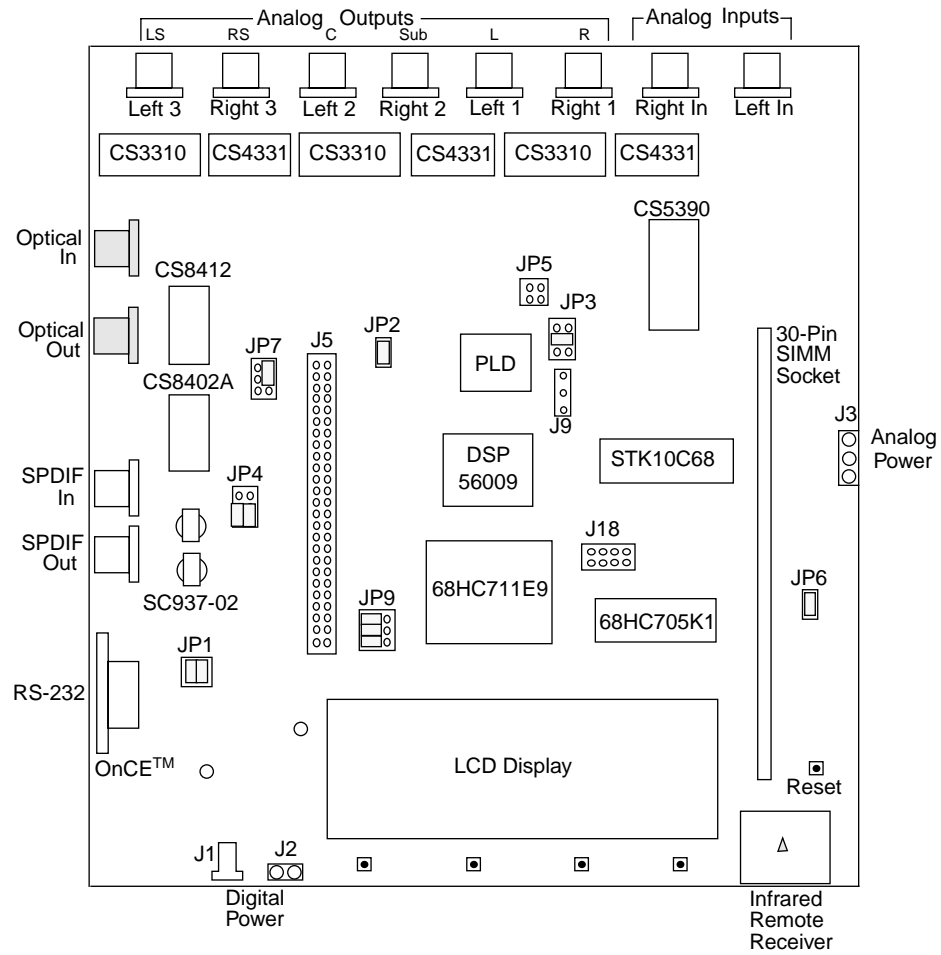


Figure C-1 DSP56009EVM Jumper Setting for Multiplexing

